# 12-Channel/8-Channel, Flash-Configurable System Monitors with Nonvolatile Fault Registers 

The MAX16070/MAX16071 flash-configurable system monitors supervise multiple system voltages. The MAX16070/MAX16071 can also accurately monitor ( $\pm 2.5 \%$ ) one current channel using a dedicated highside current-sense amplifier. The MAX16070 monitors up to twelve system voltages simultaneously, and the MAX16071 monitors up to eight supply voltages. These devices integrate a selectable differential or single-ended analog-to-digital converter (ADC). Device configuration information, including overvoltage and undervoltage limits and timing settings are stored in nonvolatile flash memory. During a fault condition, fault flags and channel voltages can be automatically stored in the nonvolatile flash memory for later read-back.
The internal $1 \%$ accurate 10 -bit ADC measures each input and compares the result to one overvoltage, one undervoltage, and one early warning limit that can be configured as either undervoltage or overvoltage. A fault signal asserts when a monitored voltage falls outside the set limits. Up to three independent fault output signals are configurable to assert under various fault conditions.
Because the MAX16070/MAX16071 support a powersupply voltage of up to 14 V , they can be powered directly from the 12 V intermediate bus in many systems.
The MAX16070/MAX16071 include eight/six programmable general-purpose inputs/outputs (GPIOs). GPIOs are flash configurable as dedicated fault outputs, as a www.D watchodog q月put or output, or as a manual reset.

The MAX16070/MAX16071 feature nonvolatile fault memory for recording information during system shutdown events. The fault logger records a failure in the internal flash and sets a lock bit protecting the stored fault data from accidental erasure. An SMBus ${ }^{\text {TM }}$ or a JTAG serial interface configures the MAX16070/MAX16071. The MAX16070/MAX16071 are available in a 40-pin, $6 \mathrm{~mm} \times$ 6 mm , TQFN package. Both devices are fully specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## Applications

[^0]Features

- Operate from 2.8V to 14 V
- $\pm 2.5 \%$ Current-Monitoring Accuracy
- 1\% Accurate 10-Bit ADC Monitors 12/8 Voltage Inputs
- Single-Ended or Differential ADC for System Voltage/Current Monitoring
- Integrated High-Side, Current-Sense Amplifier
- 12/8 Monitored Inputs with Overvoltage/ Undervoltage/Early Warning Limit
- Nonvolatile Fault Event Logger
- Two Programmable Fault Outputs and One Reset Output
- Eight General-Purpose Inputs/Outputs Configurable as: Dedicated Fault Outputs Watchdog Timer Function Manual Reset Margin Enable
- SMBus (with Timeout) or JTAG Interface
- Flash Configurable Time Delays and Thresholds
- $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Operating Temperature Range

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
| :--- | :--- | :--- |
| MAX16070ETL+ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 40 TQFN-EP* |
| MAX16071ETL+ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 40 TQFN-EP* |

+ Denotes a lead(Pb)-free/RoHS-compliant package. ${ }^{*} E P=$ Exposed pad.

Pin Configuration and Typical Operating Circuits appear at end of data sheet.

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

## ABSOLUTE MAXIMUM RATINGS

VCC, CSP, CSM to GND.........................................-0.3V to +15V CSP to CSM..........................................................-0.7V to +0.7 V
MON_, GPIO_, SCL, SDA, AO, RESET to GND
(programmed as open-drain outputs). $\qquad$ -0.3V to +6V
EN, TCK, TMS, TDI to GND ....................................-0.3V to +4 V
DBP, ABP to GND...-0.3V to the lower of +3 V and ( $\mathrm{V} C \mathrm{C}+0.3 \mathrm{~V}$ ) TDO, GPIO_, RESET
(programmed as push-pull outputs) .... -0.3 V to (VDBP +0.3 V )

Input/Output Current .........................................................20mA
Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ )
40-Pin TQFN (derate $26.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ )....... 2105 mW
Operating Temperature Range .......................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature .................................................... $150^{\circ} \mathrm{C}$
Storage Temperature Range............................ $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (soldering, 10s) ................................ $+300^{\circ} \mathrm{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

$\left(\mathrm{VCC}=2.8 \mathrm{~V}\right.$ to $14 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise specified. Typical values are at $\mathrm{ABP}=\mathrm{DBP}=\mathrm{VCC}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Voltage Range | VCC | Reset output asserted low | 1.2 |  |  | V |
|  |  | (Note 2) | 2.8 |  | 14 |  |
| Undervoltage Lockout (Rising) | VuvLo | Minimum voltage on $V_{C C}$ to ensure the device is flash configurable |  |  | 2.7 | V |
| Undervoltage Lockout Hysteresis | VUVLO_HYS |  |  | 100 |  | mV |
| Minimum Flash Operating Voltage | $V_{\text {flash }}$ | Minimum voltage on $V_{C C}$ to ensure flash erase and write operations | 2.7 |  |  | V |
| Supply Current | ICC | No load on output pins |  | 4.5 | 7 | mA |
|  |  | During flash writing cycle |  | 10 | 14 |  |
| ABP Regulator Voltage | VABP | CABP $=1 \mu \mathrm{~F}$, no load, $\mathrm{VCC}=5 \mathrm{~V}$ | 2.85 | 3 | 3.15 | V |
| DBP Regulator Voltage | VDBP | CABP $=1 \mu \mathrm{~F}$, no load, $\mathrm{VCC}=5 \mathrm{~V}$ | 2.8 | 3 | 3.1 | V |
| Boot Time | tBOOT | VCC > VUVLO |  | 200 | 350 | $\mu \mathrm{s}$ |
| Flash Writing Time |  | 8-byte word |  | 122 |  | ms |
| Internal Timing Accuracy |  | (Note 3) | -8 |  | +8 | \% |
| EN Input Voltage | VTH_EN_R | EN voltage rising |  | 1.41 |  | V |
|  | VTH_EN_F | EN voltage falling | 1.365 | 1.39 | 1.415 |  |
| EN Input Current | IEN |  | -0.5 |  | +0.5 | $\mu \mathrm{A}$ |
| Input Voltage Range |  |  | 0 |  | 5.5 | V |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

## ELECTRICAL CHARACTERISTICS (continued)

$\left(V_{C C}=2.8 \mathrm{~V}\right.$ to $14 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise specified. Typical values are at $\mathrm{ABP}=\mathrm{DBP}=\mathrm{V}_{C C}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. $)$ (Note 1)

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADC DC ACCURACY |  |  |  |  |  |  |  |
| Resolution |  |  |  |  |  | 10 | Bits |
| Gain Error | ADCGAIN | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  |  | 0.35 | \% |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  | 0.70 |  |
| Offset Error | ADCoff |  |  |  |  | 1 | LSB |
| Integral Nonlinearity | ADCINL |  |  |  |  | 1 | LSB |
| Differential Nonlinearity | ADCDNL |  |  |  |  | 1 | LSB |
| ADC Total Monitoring Cycle Time | tCYCLE | No MON_ fault detected |  |  | 40 | 50 | $\mu \mathrm{S}$ |
| ADC IN_ Ranges |  | $1 \mathrm{LSB}=5.43 \mathrm{mV}$ |  | 5.56 |  |  | V |
|  |  | $1 \mathrm{LSB}=2.72 \mathrm{mV}$ |  | 2.78 |  |  |  |
|  |  | $1 \mathrm{LSB}=1.36 \mathrm{mV}$ |  | 1.39 |  |  |  |
| CURRENT SENSE |  |  |  |  |  |  |  |
| CSP Input-Voltage Range | VCSP |  |  | 3 |  | 14 | V |
| Input Bias Current | ICSP |  |  |  | 14 | 25 | $\mu \mathrm{A}$ |
|  | ICSM | $V_{\text {CSP }}=\mathrm{V}_{\text {CSM }}$ |  |  | 3 | 5 |  |
| CSP Total Unadjusted Error | CSPERR | (Note 4) |  |  |  | 2 | \%FSR |
| Overcurrent Differential Threshold | OVCTH | VCSP - <br> VCSM | Gain $=48$ | 21.5 | 25 | 30.5 | mV |
|  |  |  | Gain $=24$ | 46 | 51 | 56 |  |
|  |  |  | Gain $=12$ | 94 | 101 | 108 |  |
|  |  |  | Gain $=6$ | 190 | 202 | 210 |  |
| VSENSE Fault Threshold Hysteresis | OVCHYS |  |  | 0.5 |  |  | \% OVCTH |
| ataSheet4U.com <br> Secondary Overcurrent Threshold Timeout | OVCDEL | r73h[6:5] = '00' |  | 0 |  |  | ms |
|  |  | r73h[6:5] = '01' |  | 3 | 4 | 5 |  |
|  |  | r73h[6:5] = '10' |  | 12 | 16 | 20 |  |
|  |  | r73h[6:5] = '11' |  | 50 | 64 | 60 |  |
| VSENSE Ranges |  | Gain = 6 |  | 232 |  |  | mV |
|  |  | Gain $=12$ |  | 116 |  |  |  |
|  |  | Gain $=24$ |  | 58 |  |  |  |
|  |  | Gain $=48$ |  | 29 |  |  |  |
| ADC Current Measurement Accuracy |  | VSENSE $=150 \mathrm{mV}$ (gain $=6$ only) |  | -2.5 | $\pm 0.2$ | +2.5 | \% |
|  |  | VSENSE $=50 \mathrm{mV}$, gain $=12$ |  | -4 | $\pm 0.2$ | +4 |  |
|  |  | VSENSE $=25 \mathrm{mV}$, gain $=24$ |  | $\pm 0.5$ |  |  |  |
|  |  | VSENSE $=10 \mathrm{mV}$, gain $=48$ |  | $\pm 1$ |  |  |  |
| Gain Accuracy |  | VSENSE $=20 \mathrm{mV}$ to $100 \mathrm{mV}, \mathrm{V}_{\mathrm{CSP}}=5 \mathrm{~V}$, gain $=6$ |  | -1.5 |  | +1.5 | \% |
| Common-Mode Rejection Ratio | CMRRSNS | VCSP > 4V |  | 80 |  |  | dB |
| Power-Supply Rejection Ratio | PSRRSNS |  |  |  | 80 |  | dB |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUTS (RESET, GPIO_) |  |  |  |  |  |
| Output-Voltage Low | VoL | ISINK $=2 \mathrm{~mA}$ |  | 0.4 | V |
|  |  | ISINK $=10 \mathrm{~mA}$, GPIO_ only |  | 0.7 |  |
|  |  | VCC $=1.2 \mathrm{~V}$, ISINK $=100 \mu \mathrm{~A}$ (RESET only) |  | 0.3 |  |
| Maximum Output Sink Current |  | Total current into RESET, GPIO_, $V_{C C}=3.3 V$ |  | 30 | mA |
| Output-Voltage High (Push-Pull) |  | ISOURCE $=100 \mu \mathrm{~A}$ | 2.4 |  | V |
| Output Leakage (Open Drain) |  |  |  | 1 | $\mu \mathrm{A}$ |
| SMBus INTERFACE |  |  |  |  |  |
| Logic-Input Low Voltage | VIL | Input voltage falling |  | 0.8 | V |
| Logic-Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ | Input voltage rising | 2.0 |  | V |
| Input Leakage Current |  | IN = GND or VCC | -1 | +1 | $\mu \mathrm{A}$ |
| Output Sink Current | VOL | ISINK $=3 \mathrm{~mA}$ |  | 0.4 | V |
| Input Capacitance | CIn |  |  | 5 | pF |
| SMBus Timeout | ttimeout | SCL time low for reset | 25 | 35 | ms |
| INPUTS (A0, GPIO_) |  |  |  |  |  |
| Input Logic-Low | VIL |  |  | 0.8 | V |
| Input Logic-High | $\mathrm{V}_{\mathrm{IH}}$ |  | 2.0 |  | V |
| WDI Pulse Width | twDI |  | 100 |  | ns |
| $\overline{\overline{M R}}$ Pulse Width | tMR |  | 1 |  | $\mu \mathrm{s}$ |
| $\overline{\mathrm{MR}}$ to RESET Delay |  |  |  | 0.5 | $\mu \mathrm{s}$ |
| $\overline{\mathrm{MR}}$ Glitch Rejection |  |  |  | 100 | ns |
| SMBus TIMMING |  |  |  |  |  |
| Serial Clock Frequency | fSCL |  |  | 400 | kHz |
| Bus Free Time Between STOP and START Condition | tBUF |  | 1.3 |  | $\mu \mathrm{s}$ |
| START Condition Setup Time | tSU:STA |  | 0.6 |  | $\mu \mathrm{s}$ |
| START Condition Hold Time | thD:STA |  | 0.6 |  | $\mu \mathrm{s}$ |
| STOP Condition Setup Time | tSU:STO |  | 0.6 |  | $\mu \mathrm{s}$ |
| Clock Low Period | tLOW |  | 1.3 |  | $\mu \mathrm{s}$ |
| Clock High Period | thigh |  | 0.6 |  | $\mu \mathrm{S}$ |
| Data Setup Time | tSU:DAT |  | 100 |  | ns |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

## ELECTRICAL CHARACTERISTICS (continued)

$\left(V_{C C}=2.8 \mathrm{~V}\right.$ to $14 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise specified. Typical values are at $\mathrm{ABP}=\mathrm{DBP}=\mathrm{V}_{C C}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Fall Time | tof | CBUS $=10 \mathrm{pF}$ to 400pF |  |  | 250 | ns |
| Data Hold Time | tHD:DAT | From 50\% SCL falling to SDA change | 0.3 |  | 0.9 | $\mu \mathrm{S}$ |
| Pulse Width of Spike Suppressed | tSP |  |  | 30 |  | ns |
| JTAG INTERFACE |  |  |  |  |  |  |
| TDI, TMS, TCK Logic-Low Input Voltage | VIL | Input voltage falling |  |  | 0.8 | V |
| TDI, TMS, TCK Logic-High Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | Input voltage rising | 2 |  |  | V |
| TDO Logic-Output Low Voltage | VOL | ISINK $=3 \mathrm{~mA}$ |  |  | 0.4 | V |
| TDO Logic-Output High Voltage | VOH | ISOURCE $=200 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| TDI, TMS Pullup Resistors | RPU | Pullup to DBP | 40 | 50 | 60 | $\mathrm{k} \Omega$ |
| I/O Capacitance | Cl/o |  |  | 5 |  | pF |
| TCK Clock Period | t1 |  |  |  | 1000 | ns |
| TCK High/Low Time | t2, t3 |  | 50 | 500 |  | ns |
| TCK to TMS, TDI Setup Time | t4 |  | 15 |  |  | ns |
| TCK to TMS, TDI Hold Time | t5 |  | 10 |  |  | ns |
| TCK to TDO Delay | t6 |  |  |  | 500 | ns |
| TCK to TDO High-Z Delay | t7 |  |  |  | 500 | ns |

Note 1: Specifications are guaranteed for the stated global conditions, unless otherwise noted. $100 \%$ production tested at $T_{A}=$ $+25^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$. Specifications at $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ are guaranteed by design.
Note 2: For 3.3V VCC applications, connect $\mathrm{V}_{\mathrm{C}}$, DBP, and ABP together. For higher supply applications, connect $\mathrm{V}_{\mathrm{CC}}$ only to the supply rail.
www. DNote 3:tAPpplies to RESET, fault, autoretry, sequence delays, and watchdog timeout.
Note 4: Total unadjusted error is a combination of gain, offset, and quantization error.

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 



Figure 1. SMBus Timing Diagram


Figure 2. JTAG Timing Diagram

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

(Typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


TRANSIENT DURATION
vs. THRESHOLD OVERDRIVE (EN)


MR TO RESET PROPAGATION DELAY vs. TEMPERATURE

meRATURE ( ${ }^{\circ} \mathrm{C}$ )

NORMALIZED TIMING ACCURACY
vs. TEMPERATURE


OUTPUT VOLTAGE vs. SINK CURRENT (OUT = LOW)


Typical Operating Characteristics

NORMALIZED EN THRESHOLD vs. TEMPERATURE


MON DEGLITCH
vs. TRANSIENT DURATION


OUTPUT-VOLTAGE HIGH vs. SOURCE CURRENT (PUSH-PULL OUTPUT)


# 12-Channel/8-Channel Flash-Configurable System Monitors with Nonvolatile Fault Registers 


(Typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


NORMALIZED CURRENT-SENSE ACCURACY vs. TEMPERATURE

 vs. CSP-CSM OVERDRIVE


DIFFERENTIAL NONLINEARITY vs. CODE


CURRENT-SENSE ACCURACY
vs. CSP-CSM VOLTAGE


RESET OUTPUT CURRENT
vs. SUPPLY VOLTAGE


## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

| PIN |  | NAME | FUNCTION |
| :---: | :---: | :---: | :---: |
| MAX16070 | MAX16071 |  |  |
| $\begin{gathered} 1-5,34,35 \\ 40 \end{gathered}$ | $\begin{gathered} 1-5,37,38 \\ 40 \end{gathered}$ | MON2-MON6, MON7, MON8, MON1 | Monitor Voltage Input 1-Monitor Voltage Input 8. Set monitor voltage range through configuration registers. Measured value written to the ADC register can be read back through the SMBus or JTAG interface. |
| 6 | 6 | CSP | Current-Sense Amplifier Positive Input. Connect CSP to the source side of the external sense resistor. |
| 7 | 7 | CSM | Current-Sense Amplifier Negative Input. Connect CSM to the load side of the external sense resistor. |
| 8 | 8 | RESET | Configurable Reset Output |
| 9 | 9 | TMS | JTAG Test Mode Select |
| 10 | 10 | TDI | JTAG Test Data Input |
| 11 | 11 | TCK | JTAG Test Clock |
| 12 | 12 | TDO | JTAG Test Data Output |
| 13 | 13 | SDA | SMBus Serial-Data Open-Drain Input/Output |
| 14 | 14 | A0 | Four-State SMBus Address. Address sampled upon POR. |
| 15 | 15 | SCL | SMBus Serial Clock Input |
| 16, 33 | 16, 36 | GND | Ground |
| 17, 18 | - | GPIO7, GPIO8 | General-Purpose Input/Output 7 and General-Purpose Input/Output 8. GPIO_s can be configured to act as a TTL input, a push-pull, open-drain, or high-impedance output or a pulldown circuit during a fault event or reverse sequencing. |
| 19-24 <br> ataSheet4U.com | 17-22 | GPIO1-GPIO6 | General-Purpose Input/Output 1-General-Purpose Input/Output 6. GPIO_s can be configured to act as a TTL input, a push-pull, open-drain, or highimpedance output or a pulldown circuit during a fault event. |
| 25, 26, 27, 29 | $\begin{aligned} & 23-28, \\ & 30,39 \end{aligned}$ | N.C. | No Connection. Not internally connected. |
| 28 | 29 | EN | Analog Enable Input. All outputs deassert when $\mathrm{V}_{\mathrm{EN}}$ is below the enable threshold. |
| 30 | 31, 32 | DBP | Digital Bypass. All push-pull outputs are referenced to DBP. Bypass DBP with a $1 \mu \mathrm{~F}$ capacitor to GND. |
| 31 | 33, 34 | VCC | Device Power Supply. Connect Vcc to a voltage from 2.8 V to 14 V . Bypass VCc with a $10 \mu \mathrm{~F}$ capacitor to GND. |
| 32 | 35 | ABP | Analog Bypass. Bypass ABP with a $1 \mu \mathrm{~F}$ ceramic capacitor to GND. |
| 36-39 | - | MON9MON12 | Monitor Voltage Input 9-Monitor Voltage Input 12. Set monitor voltage range through configuration registers. Measured value written to the ADC register can be read back through the SMBus or JTAG interface. |
| - | - | EP | Exposed Pad. Internally connected to GND. Connect to ground, but do not use as the main ground connection. |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers



# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

## Detailed Description

The MAX16070 monitors up to twelve system power supplies and the MAX16071 can monitor up to eight system power supplies. After boot-up, if EN is high and the software enable bit is set to ' 1 ,' monitoring begins based on the configuration stored in flash. An internal multiplexer cycles through each MON_ input. At each multiplexer stop, the 10 -bit ADC converts the monitored analog voltage to a digital result and stores the result in a register. Each time a conversion cycle ( $50 \mu \mathrm{~s}$, max) completes, internal logic circuitry compares the conversion results to the overvoltage and undervoltage thresholds stored in memory. When a result violates a programmed threshold, the conversion can be configured to generate a fault. GPIO_ can be programmed to assert on combinations of faults. Additionally, faults can be configured to shut off the system and trigger the nonvolatile fault logger, which writes all fault information automatically to the flash and write-protects the data to prevent accidental erasure.
The MAX16070/MAX16071 contain both SMBus and JTAG serial interfaces for accessing registers and flash. Use only one interface at any given time. For more information on how to access the internal memory through these interfaces, see the SMBus-Compatible Interface and JTAG Serial Interface sections. The memory map is divided into three pages with access controlled by special SMBus and JTAG commands.
The factory-default values at POR (power-on reset) for all RAM registers are '0's. POR occurs when VCC reaches the undervoltage-lockout threshold (UVLO) of 2.8 V (max). At POR, the device begins a boot-up sequence. During the boot-up sequence, all monitored inputs are masked
from initiating faults and flash contents are copied to the respective register locations. During boot-up, the MAX16070/MAX16071 are not accessible through the serial interface. The boot-up sequence takes up to $150 \mu \mathrm{~s}$, after which the device is ready for normal operation. RESET is asserted low up to the boot-up phase and remains asserted for its programmed timeout period once sequencing is completed and all monitored channels are within their respective thresholds. Up to the boot-up phase, the GPIO_s are high impedance.

Power
Apply 2.8 V to 14 V to VCC to power the MAX16070/ MAX16071. Bypass VCc to ground with a $10 \mu \mathrm{~F}$ capacitor. Two internal voltage regulators, ABP and DBP, supply power to the analog and digital circuitry within the device. For operation at 3.6 V or lower, disable the regulators by connecting ABP and DBP to $\mathrm{V}_{\mathrm{C}}$.
ABP is a 3.0 V (typ) voltage regulator that powers the internal analog circuitry. Bypass ABP to GND with a $1 \mu \mathrm{~F}$ ceramic capacitor installed as close to the device as possible.
DBP is an internal 3.0 V (typ) voltage regulator. DBP powers flash and digital circuitry. All push-pull outputs refer to DBP. Bypass the DBP output to GND with a $1 \mu \mathrm{~F}$ ceramic capacitor installed as close as possible to the device.
Do not power external circuitry from ABP or DBP.
Enable
To enable monitoring, the voltage at EN must be above 1.4 V and the software enable bit in $\mathrm{r} 73 \mathrm{~h}[0]$ must be set to ' 1 .' To power down and disable monitoring, either pull EN below 1.35 V or set the Software Enable bit to ' 0 .' See Table 1 for the software enable bit configurations. Connect $E N$ to ABP if not used.

Table 1. Software Enable Configurations

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 73h | 273h | [0] | Software enable |
|  |  | [1] | Reserved |
|  |  | [2] | 1 = Margin mode enabled |
|  |  | [3] | Early warning threshold select $0=$ Early warning is undervoltage <br> 1 = Early warning is overvoltage |
|  |  | [4] | Independent watchdog mode enable <br> $1=$ Watchdog timer is independent of sequencer <br> $0=$ Watchdog timer boots after sequence completes |

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

When in the monitoring state, a register bit, ENRESET, is set to a ' 1 ' when EN falls below the undervoltage threshold. This register bit latches and must be cleared through software. This bit indicates if RESET asserted low due to EN going under the threshold. The POR state of ENRESET is ' 0 '. The bit is only set on a falling edge of the EN comparator output or the software enable bit.

## Voltage/Current Monitoring

The MAX16070/MAX16071 feature an internal 10-bit ADC that monitors the MON_ voltage inputs. An internal multiplexer cycles through each of the enabled inputs, taking less than $40 \mu \mathrm{~s}$ for a complete monitoring cycle. Each acquisition takes approximately $3.2 \mu \mathrm{~s}$. At each multiplexer stop, the 10 -bit ADC converts the analog input to a digital result and stores the result in a register. ADC conversion results are stored in registers rooh to r1Ah (see Table 6). Use the SMBus or JTAG serial interface to read ADC conversion results.
The MAX16070 provides twelve inputs, MON1 to MON12, for voltage monitoring. The MAX16071 provides eight inputs, MON1 to MON8, for voltage monitoring. Each input voltage range is programmable in registers r43h to r45h (see Table 5). When MON_ configuration registers are set to '11,' MON_ voltages are not monitored, and the multiplexer does not stop at these inputs, decreasing the total cycle time. These inputs cannot be configured to trigger fault conditions.


Figure 3. Differential Measurement Connections

The three programmable thresholds for each monitored voltage include an overvoltage, an undervoltage, and a secondary warning threshold that can be set in r73h[3] to be either an undervoltage or overvoltage threshold. See the Faults section for more information on setting overvoltage and undervoltage thresholds. All voltage thresholds are 8 bits wide. The 8 MSBs of the 10-bit ADC conversion result are compared to these overvoltage and undervoltage thresholds.
Inputs that are not enabled are not converted by the ADC; they contain the last value acquired before that channel was disabled.
The ADC conversion result registers are reset to 00h at boot-up. These registers are not reset when a reboot command is executed.
Configure the MAX16070/MAX16071 for differential mode in r46h (Table 5). The possible differential pairs are MON1/MON2, MON3/MON4, MON5/MON6, MON7/ MON8, MON9/MON10, MON11/MON12 with the first input always being at a higher voltage than the second. Use differential voltage sensing to eliminate voltage offsets or measure supply current. See Figure 3. In differential mode, the odd-numbered MON_ input measures the absolute voltage with respect to GND while the result of the even input is the difference between the odd and even inputs. See Figure 3 for the typical differential measurement circuit.


Figure 4. Current-Sense Amplifier

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

## Boot-Up Delay

Once EN is above its threshold and the software-enable bit is set, a boot-up delay occurs before monitoring begins. This delay is configured in register 77h[3:0] as shown in Tables 2 and 3.

## Internal Current-Sense Amplifier

The current-sense inputs, CSP/CSM, and a currentsense amplifier facilitate power monitoring (see Figure 4). The voltage on CSP relative to GND is also monitored by the ADC when the current-sense amplifier is enabled with $\mathrm{r} 47 \mathrm{~h}[0]$. The conversion results are located in registers r19h and r1Ah (see Table 6). There are two selectable voltage ranges for CSP set by r47h[1], see Table 4. Although the voltage can be monitored over SMBus or JTAG, this voltage has no threshold comparators and cannot trigger any faults. Regarding the current-sense amplifier, there are four selectable ranges and the ADC output for a current-sense conversion is:

$$
X_{A D C}=\left(V_{\text {SENSE }} \times A V\right) / 1.4 \mathrm{~V} \times\left(2^{8}-1\right)
$$

where $X_{A D C}$ is the 8 -bit decimal ADC result in register r18h, VSENSE is VCSP - VCSM, and AV is the currentsense voltage gain set by r47h[3:2].

In addition, there are two programmable current-sense trip thresholds: primary overcurrent and secondary overcurrent. For fast fault detection, the primary overcurrent threshold is implemented with an analog comparator connected to the internal OVERC signal. The OVERC signal can be output on one of the GPIO_s. See the General-Purpose Inputs/Outputs section for configuring the GPIO_ to output the $\overline{\text { OVERC }}$ signal. The primary threshold is set by:
ITH = VCSTH/RSENSE
where ITH is the current threshold to be set, VCSTH is the threshold set by r47h[3:2], and RSENSE is the value of the sense resistor. See Table 4 for a description of r47h. $\overline{\text { OVERC }}$ depends only on the primary overcurrent threshold. The secondary overcurrent threshold is implemented through ADC conversions and digital comparison set by r6Ch. The secondary overcurrent threshold includes programmable time delay options located in r73h[6:5]. Primary and secondary current-sense faults are enabled/disabled through r47h[0].

## Table 2. Boot-Up Delay Register

| REGISTER <br> ADDRESS | FLASH <br> ADDRESS | BIT RANGE |  |
| :---: | :---: | :---: | :--- |
| 77 h | 277 h | $[3: 0]$ | Boot-up delay |
|  |  | Reserved |  |

Table 3. Boot-Up Delay Values

| CODE | VALUE |
| :---: | :---: |
| 0000 | $25 \mu \mathrm{~s}$ |
| 0001 | $500 \mu \mathrm{~s}$ |
| 0010 | 1 ms |
| 0011 | 2 ms |
| 0100 | 3 ms |
| 0101 | 4 ms |
| 0110 | 6 ms |
| 0111 | 8 ms |
| 1000 | 10 ms |
| 1001 | 12 ms |
| 1010 | 25 ms |
| 1011 | 100 ms |
| 1100 | 200 ms |
| 1101 | 400 ms |
| 1110 | 800 ms |
| 1111 | 1.6 s |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Table 4. Overcurrent Primary Threshold and Current-Sense Control

| REGISTER ADDRESS | FLASH ADDRESS | $\begin{gathered} \text { BIT } \\ \text { RANGE } \end{gathered}$ | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 47h | 247h | [0] | $1=$ Current sense is enabled <br> $0=$ Current sense is disabled |
|  |  | [1] | $\begin{aligned} & 1=\text { CSP full-scale range is } 14 \mathrm{~V} \\ & 0=\text { CSP full-scale range is } 7 \mathrm{~V} \end{aligned}$ |
|  |  | [3:2] | Overcurrent primary threshold and current-sense gain setting $00=200 \mathrm{mV}$ threshold, $\mathrm{AV}=6 \mathrm{~V} / \mathrm{V}$ <br> $01=100 \mathrm{mV}$ threshold, $\mathrm{AV}=12 \mathrm{~V} / \mathrm{V}$ <br> $10=50 \mathrm{mV}$ threshold, $\mathrm{AV}=24 \mathrm{~V} / \mathrm{V}$ <br> $11=25 \mathrm{mV}$ threshold, $\mathrm{AV}=48 \mathrm{~V} / \mathrm{V}$ |
| 73h | 273h | [6:5] | Overcurrent secondary threshold deglitch $\begin{aligned} & 00=\text { No delay } \\ & 01=14 \mathrm{~ms} \\ & 10=15 \mathrm{~ms} \\ & 11=60 \mathrm{~ms} \end{aligned}$ |

Table 5. ADC Configuration Registers


## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Table 5. ADC Configuration Registers (continued)


## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 46h | 246h | [0] | Differential conversion ADC1, ADC2 <br> 0 = Disabled <br> 1 = Enabled |
|  |  | [1] | Differential conversion ADC3, ADC4 <br> 0 = Disabled <br> 1 = Enabled |
|  |  | [2] | Differential conversion ADC5, ADC6 <br> 0 = Disabled <br> 1 = Enabled |
|  |  | [3] | Differential conversion ADC7, ADC8 $\begin{aligned} & 0=\text { Disabled } \\ & 1=\text { Enabled } \end{aligned}$ |
|  |  | [4] | Differential conversion ADC9, ADC10 $\begin{aligned} & 0=\text { Disabled } \\ & 1=\text { Enabled } \end{aligned}$ |
|  |  | [5] | Differential conversion ADC11, ADC12 <br> 0 = Disabled <br> 1 = Enabled |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Table 6. ADC Conversion Results (Read Only)


## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

## General-Purpose Inputs/Outputs

GPIO1 to GPIO8 are programmable general-purpose inputs/outputs. GPIO1-GPIO8 are configurable as a manual reset input, a watchdog timer input and output, logic inputs/outputs, fault-dependent outputs. When programmed as outputs, GPIO_s are open drain or pushpull. See Tables 8 and 9 for more detailed information on configuring GPIO1 to GPIO8.

When GPIO1 to GPIO8 are configured as general-purpose inputs/outputs, read values from the GPIO_ ports through r1Eh and write values to GPIO_s through r3Eh. Note that r3Eh has a corresponding flash register, which programs the default state of a general-purpose output. See Table 7 for more information on reading and writing to the GPIO_

## Table 7. GPIO_ State Registers

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 1Eh | - | [0] | GPIO1 input state |
|  |  | [1] | GPIO2 input state |
|  |  | [2] | GPIO3 input state |
|  |  | [3] | GPIO4 input state |
|  |  | [4] | GPIO5 input state |
|  |  | [5] | GPIO6 input state |
|  |  | [6] | GPIO7 input state |
|  |  | [7] | GPIO8 input state |
| 3Eh | 23Eh | [0] | GPIO1 output state |
|  |  | [1] | GPIO2 output state |
|  |  | [2] | GPIO3 output state |
|  |  | [3] | GPIO4 output state |
|  |  | [4] | GPIO5 output state |
|  |  | [5] | GPIO6 output state |
|  |  | [6] | GPIO7 output state |
|  |  | [7] | GPIO8 output state |

Table 8. GPIO_Configuration Registers

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 3Fh | 23Fh | [2:0] | GPIO1 configuration |
|  |  | [5:3] | GPIO2 configuration |
|  |  | [7:6] | GPIO3 configuration (LSB) |
| 40h | 240h | [0] | GPIO3 configuration (MSB) |
|  |  | [3:1] | GPIO4 configuration |
|  |  | [6:4] | GPIO5 configuration |
|  |  | [7] | GPIO6 configuration (LSB) |
| 41h | 241h | [1:0] | GPIO6 configuration (MSB) |
|  |  | [4:2] | GPIO7 configuration |
|  |  | [7:5] | GPIO8 configuration |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Table 8. GPIO_Configuration Registers (continued)

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 42h | 242h | [0] | Output configuration for GPIO1 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [1] | Output configuration for GPIO2 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [2] | Output configuration for GPIO3 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [3] | Output configuration for GPIO4 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [4] | Output configuration for GPIO5 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [5] | Output configuration for GPIO6 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [6] | Output configuration for GPIO7 <br> 0 = Push-pull <br> 1 = Open drain |
|  |  | [7] | Output configuration for GPIO8 <br> 0 = Push-pull <br> 1 = Open drain |

www. Table 9. GPIO_ Function Configuration Bits

| CODE | GPIO1 | GPIO2 | GPIO3 | GPIO4 | GPIO5 | GPIO6 | GPIO7 | GPIO8 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 000 | Logic input | Logic input | Logic input | Logic input | Logic input | Logic input | Logic input | Logic input |
| 001 | Logic output | Logic output | Logic output | Logic output | Logic output | Logic output | Logic output | Logic output |
| 010 | Fault2 output | Fault2 output | Fault2 output | Fault2 output | Fault2 output | Fault2 output | Fault2 output | Fault2 output |
| 011 | Fault1 output | Fault1 output | - | Fault1 output | Fault1 output | Fault1 output | Fault1 output | FAULT output |
| 100 | $\overline{\text { ANY_FAULT }}$ output | - | $\overline{\text { ANY_FAULT }}$ <br> output | $\overline{\text { ANY_FAULT }}$ <br> output | $\overline{\text { ANY_FAULT }}$ <br> output | - | ANY_FAULT <br> output | - |
| 101 | OVERC output | $\overline{\text { OVERC }}$ output | OVERC output | OVERC output | OVERC output | $\overline{\text { OVERC }}$ output | OVERC output | OVERC output |
| 110 | $\overline{\mathrm{MR}}$ input | $\overline{\text { WDO }}$ output | $\overline{\mathrm{MR}}$ input | $\overline{\text { WDO output }}$ | $\overline{\mathrm{MR}}$ input | $\overline{\text { WDO }}$ <br> output | $\overline{\mathrm{MR}}$ input | $\overline{\text { WDO output }}$ |
| 111 | WDI input | - | - | EXTFAULT input/output | - | $\overline{\text { MARGIN }}$ input | - | EXTFAULT input/output |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Fault1 and Fault2
GPIO1 to GPIO8 are configurable as dedicated fault outputs, Fault1 or Fault2. Fault outputs can assert on one or more overvoltage, undervoltage, or early warning conditions for selected inputs, as well as the secondary overcurrent comparator. Fault1 and Fault2 dependencies
are set using registers r36h to r3Ah. See Table 10. When a fault output depends on more than one MON_, the fault output asserts when one or more MON_ exceeds a programmed threshold voltage. These fault outputs act independently of the critical fault system, described in the Critical Faults section.

## Table 10. Fault1 and Fault2 Dependencies

| REGISTER ADDRESS | FLASH ADDRESS | $\begin{gathered} \text { BIT } \\ \text { RANGE } \end{gathered}$ | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 36h | 236h | 0 | 1 = Fault1 depends on MON1 |
|  |  | 1 | 1 = Fault1 depends on MON2 |
|  |  | 2 | 1 = Fault1 depends on MON3 |
|  |  | 3 | 1 = Fault1 depends on MON4 |
|  |  | 4 | 1 = Fault1 depends on MON5 |
|  |  | 5 | 1 = Fault1 depends on MON6 |
|  |  | 6 | 1 = Fault1 depends on MON7 |
|  |  | 7 | 1 = Fault1 depends on MON8 |
| 37h | 237h | 0 | 1 = Fault1 depends on MON9 |
|  |  | 1 | 1 = Fault1 depends on MON10 |
|  |  | 2 | 1 = Fault1 depends on MON11 |
|  |  | 3 | 1 = Fault1 depends on MON12 |
|  |  | 4 | $1=$ Fault1 depends on the overvoltage thresholds of the inputs selected by r36h and r37h[3:0] |
|  |  | 5 | 1 = Fault1 depends on the undervoltage thresholds of the inputs selected by r36h and r37h[3:0] |
|  |  | 6 | 1 = Fault1 depends on the early warning thresholds of the inputs selected by r36h and r37h[3:0] |
|  |  | 7 | $0=$ Fault1 is an active-low digital output 1 = Fault 1 is an active-high digital output |
| 38h | 238h | [0] | 1 = Fault2 depends on MON1 |
|  |  | [1] | 1 = Fault2 depends on MON2 |
|  |  | [2] | 1 = Fault2 depends on MON3 |
|  |  | [3] | 1 = Fault2 depends on MON4 |
|  |  | [4] | 1 = Fault2 depends on MON5 |
|  |  | [5] | 1 = Fault2 depends on MON6 |
|  |  | [6] | 1 = Fault2 depends on MON7 |
|  |  | [7] | 1 = Fault2 depends on MON8 |

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

Table 10. Fault1 and Fault2 Dependencies (continued)

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 39h | 239h | [0] | 1 = Fault2 depends on MON9 |
|  |  | [1] | 1 = Fault2 depends on MON10 |
|  |  | [2] | 1 = Fault2 depends on MON11 |
|  |  | [3] | 1 = Fault2 depends on MON12 |
|  |  | [4] | 1 = Fault2 depends on the overvoltage thresholds of the inputs selected by r38h and r39h[3:0] |
|  |  | [5] | 1 = Fault2 depends on the undervoltage thresholds of the inputs selected by r38h and r39h[3:0] |
|  |  | [6] | 1 = Fault2 depends on the early warning thresholds of the inputs selected by r38h and r39h[3:0] |
|  |  | [7] | $0=$ Fault2 is an active-low digital output $1=$ Fault2 is an active-high digital output |
| 3 Ah | 23Ah | [0] | 1 = Fault1 depends on secondary overcurrent comparator |
|  |  | [1] | 1 = Fault2 depends on secondary overcurrent comparator |
|  |  | [7:2] | Reserved |

## $\overline{\text { ANY_FAULT }}$

GPIO1, GPIO3, GPIO4, GPIO5, and GPIO7 are configurable to assert low during any fault condition.

## Overcurrent Comparator (OVERC)

GPIO1 to GPIO8 are configurable to assert low when the voltage across CSP and CSM exceed the primary overcurrent threshold. See the Internal Current-Sense www.DeAmpplifiekssection for more details.

## Manual Reset ( $\overline{M R}$ )

GPIO1, GPIO3, GPIO5, and GPIO7 are configurable to act as an active-low manual reset input, $\overline{\mathrm{MR}}$. Drive $\overline{\mathrm{MR}}$ low to assert RESET. RESET remains asserted for the selected reset timeout period after $\overline{\mathrm{MR}}$ transitions from low to high.

Watchdog Input (WDI) and Output (WDO)
GPIO2, GPIO4, GPIO6, and GPIO8 are configurable as the watchdog timer output, WDO. GPIO1 is configurable as WDI. See Table 17 for configuration details. WDO is an active-low output. See the Watchdog Timer section for more information about the operation of the watchdog timer.

## External Fault (EXTFAULT)

GPIO4 and GPIO8 are configurable as the external fault input/output. When configured as push-pull, EXTFAULT signals that a critical fault has occurred on one or more monitored voltages or current. When configured as open-drain, EXTFAULT can be asserted low by an external circuit to trigger a critical fault. This signal can be used to cascade multiple MAX16070/MAX16071s.

One configuration bit determines the behavior of the MAX16070/MAX16071 when EXTFAULT is pulled low by some other device. If register bit r6Dh[2] is set, EXTFAULT going low triggers a nonvolatile fault log operation.

## Faults

The MAX16070/MAX16071 monitor the input (MON_) channels and compare the results with an overvoltage threshold, an undervoltage threshold, and a selectable overvoltage or undervoltage early warning threshold. Based on these conditions, the MAX16070/MAX16071 assert various fault outputs and save specific information about the channel conditions and voltages into the nonvolatile flash. Once a critical fault event occurs, the failing channel condition, ADC conversions at the time of the fault, or both can be saved by configuring the event logger. The event logger records a single failure in the internal flash and sets a lock bit that protects the stored fault data from accidental erasure on a subsequent power-up.
An overvoltage event occurs when the voltage at a monitored input exceeds the overvoltage threshold for that input. An undervoltage event occurs when the voltage at a monitored input falls below the undervoltage threshold. Fault thresholds are set in registers r48h to r6Ch as shown in Table 11. Disabled inputs are not monitored for fault conditions and are skipped over by the input multiplexer. Only the upper 8 bits of a conversion result are compared with the programmed fault thresholds.

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 48h | 248h | [7:0] | MON1 secondary threshold |
| 49h | 249h | [7:0] | MON1 overvoltage threshold |
| 4Ah | 24Ah | [7:0] | MON1 undervoltage threshold |
| 4Bh | 24Bh | [7:0] | MON2 secondary threshold |
| 4Ch | 24Ch | [7:0] | MON2 overvoltage threshold |
| 4Dh | 24Dh | [7:0] | MON2 undervoltage threshold |
| 4Eh | 24Eh | [7:0] | MON3 secondary threshold |
| 4Fh | 24Fh | [7:0] | MON3 overvoltage threshold |
| 50h | 250h | [7:0] | MON3 undervoltage threshold |
| 51h | 251h | [7:0] | MON4 secondary threshold |
| 52h | 252h | [7:0] | MON4 overvoltage threshold |
| 53h | 253h | [7:0] | MON4 undervoltage threshold |
| 54h | 254h | [7:0] | MON5 secondary threshold |
| 55h | 255h | [7:0] | MON5 overvoltage threshold |
| 56h | 256h | [7:0] | MON5 undervoltage threshold |
| 57h | 257h | [7:0] | MON6 secondary threshold |
| 58h | 258h | [7:0] | MON6 overvoltage threshold |
| 59h | 259h | [7:0] | MON6 undervoltage threshold |
| 5Ah | 25Ah | [7:0] | MON7 secondary threshold |
| 5Bh | 25Bh | [7:0] | MON7 overvoltage threshold |
| 5Ch | 25Ch | [7:0] | MON7 undervoltage threshold |
| 5Dh | 25Dh | [7:0] | MON8 secondary threshold |
| 5Eh | 25Eh | [7:0] | MON8 overvoltage threshold |
| atasiregth corm | 25Fh | [7:0] | MON8 undervoltage threshold |
| 60h | 260h | [7:0] | MON9 secondary threshold |
| 61h | 261h | [7:0] | MON9 overvoltage threshold |
| 62h | 262h | [7:0] | MON9 undervoltage threshold |
| 63h | 263h | [7:0] | MON10 secondary threshold |
| 64h | 264h | [7:0] | MON10 overvoltage threshold |
| 65h | 265h | [7:0] | MON10 undervoltage threshold |
| 66h | 266h | [7:0] | MON11 secondary threshold |
| 67h | 267h | [7:0] | MON11 overvoltage threshold |
| 68h | 268h | [7:0] | MON11 undervoltage threshold |
| 69h | 269h | [7:0] | MON12 secondary threshold |
| 6Ah | 26Ah | [7:0] | MON12 overvoltage threshold |
| 6Bh | 26Bh | [7:0] | MON12 undervoltage threshold |
| 6Ch | 26Ch | [7:0] | Secondary overcurrent threshold |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

The general-purpose inputs/outputs (GPIO1 to GPIO8) can be configured as ANY_FAULT outputs or dedicated Fault1 and Fault2 outputs to indicate fault conditions. These fault outputs are not masked by the critical fault enable bits shown in Table 14. See the General-Purpose Inputs/Outputs section for more information on configuring GPIO_s as fault outputs.

## Deglitch

Fault conditions are detected at the end of each conversion. When the voltage on an input falls outside a monitored threshold for one acquisition, the input multiplexer remains on that channel and performs several successive conversions. To trigger a fault, the input must stay
outside the threshold for a certain number of acquisitions as determined by the deglitch setting in r73h[6:5] and r74h[6:5] (see Table 12).

Fault Flags
Fault flags indicate the fault status of a particular input. The fault flag of any monitored input in the device can be read at any time from registers r1Bh and r1Ch, as shown in Table 13. Clear a fault flag by writing a ' 1 ' to the appropriate bit in the flag register. Unlike the fault signals sent to the fault outputs, these bits are masked by the Critical Fault Enable bits (see Table 14). The fault flag is only set when the matching enable bit in the critical fault enable register is also set.

Table 12. Deglitch Configuration

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 73h | 273h | [6:5] | Overcurrent comparator deglitch time $\begin{aligned} & 00=\text { No deglitch } \\ & 01=4 \mathrm{~ms} \\ & 10=15 \mathrm{~ms} \\ & 11=60 \mathrm{~ms} \end{aligned}$ |
| 74h | 274h | [6:5] | Voltage comparator deglitch configuration $00=2$ cycles <br> $01=4$ cycles <br> $10=8$ cycles <br> $11=16$ cycles |

## Table 13. Fault Flags

| REGISTER ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: |
| 1 Bh | [0] | MON1 |
|  | [1] | MON2 |
|  | [2] | MON3 |
|  | [3] | MON4 |
|  | [4] | MON5 |
|  | [5] | MON6 |
|  | [6] | MON7 |
|  | [7] | MON8 |
| 1Ch | [0] | MON9 |
|  | [1] | MON10 |
|  | [2] | MON11 |
|  | [3] | MON12 |
|  | [4] | Overcurrent |
|  | [5] | External fault (EXTFAULT) |
|  | [6] | SMB alert |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

| REGISTER ADDRESS | FLASH ADDRESS | $\begin{gathered} \text { BIT } \\ \text { RANGE } \end{gathered}$ | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 6Dh | 26Dh | [1:0] | Fault information to log <br> $00=$ Save failed line flags and ADC values in flash <br> 01 = Save only failed line flags in flash <br> 10 = Save only ADC values in flash <br> 11 = Do not save anything |
|  |  | [2] | 1 = Fault log triggered when EXTFAULT is pulled low externally |
|  |  | [7:3] | Not used |
| 6Eh | 26Eh | [0] | 1 = Fault log triggered when MON1 is below its undervoltage threshold |
|  |  | [1] | 1 = Fault log triggered when MON2 is below its undervoltage threshold |
|  |  | [2] | 1 = Fault log triggered when MON3 is below its undervoltage threshold |
|  |  | [3] | 1 = Fault log triggered when MON4 is below its undervoltage threshold |
|  |  | [4] | 1 = Fault log triggered when MON5 is below its undervoltage threshold |
|  |  | [5] | 1 = Fault log triggered when MON6 is below its undervoltage threshold |
|  |  | [6] | 1 = Fault log triggered when MON7 is below its undervoltage threshold |
|  |  | [7] | 1 = Fault log triggered when MON8 is below its undervoltage threshold |
| 6Fh | 26Fh | [0] | 1 = Fault log triggered when MON9 is below its undervoltage threshold |
|  |  | [1] | 1 = Fault log triggered when MON10 is below its undervoltage threshold |
|  |  | [2] | 1 = Fault log triggered when MON11 is below its undervoltage threshold |
|  |  | [3] | 1 = Fault log triggered when MON12 is below its undervoltage threshold |
|  |  | [4] | 1 = Fault log triggered when MON1 is above its overvoltage threshold |
|  |  | [5] | 1 = Fault log triggered when MON2 is above its overvoltage threshold |
|  |  | [6] | 1 = Fault log triggered when MON3 is above its overvoltage threshold |
|  |  | [7] | 1 = Fault log triggered when MON4 is above its overvoltage threshold |
| 70h | 270h | [0] | 1 = Fault log triggered when MON5 is above its overvoltage threshold |
|  |  | [1] | 1 = Fault log triggered when MON6 is above its overvoltage threshold |
|  |  | [2] | 1 = Fault log triggered when MON7 is above its overvoltage threshold |
|  |  | [3] | 1 = Fault log triggered when MON8 is above its overvoltage threshold |
|  |  | [4] | 1 = Fault log triggered when MON9 is above its overvoltage threshold |
|  |  | [5] | 1 = Fault log triggered when MON10 is above its overvoltage threshold |
|  |  | [6] | 1 = Fault log triggered when MON11 is above its overvoltage threshold |
|  |  | [7] | 1 = Fault log triggered when MON12 is above its overvoltage threshold |
| 71h | 271h | [0] | 1 = Fault log triggered when MON1 is above/below the early threshold warning |
|  |  | [1] | 1 = Fault log triggered when MON2 is above/below the early threshold warning |
|  |  | [2] | 1 = Fault log triggered when MON3 is above/below the early threshold warning |
|  |  | [3] | 1 = Fault log triggered when MON4 is above/below the early threshold warning |
|  |  | [4] | 1 = Fault log triggered when MON5 is above/below the early threshold warning |
|  |  | [5] | 1 = Fault log triggered when MON6 is above/below the early threshold warning |
|  |  | [6] | 1 = Fault log triggered when MON7 is above/below the early threshold warning |
|  |  | [7] | 1 = Fault log triggered when MON8 is above/below the early threshold warning |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Table 14. Critical Fault Configuration (continued)

| REGISTER ADDRESS | FLASH ADDRESS | $\begin{gathered} \text { BIT } \\ \text { RANGE } \end{gathered}$ | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 72h | 272h | [0] | 1 = Fault log triggered when MON9 is above/below the early threshold warning |
|  |  | [1] | 1 = Fault log triggered when MON10 is above/below the early threshold warning |
|  |  | [2] | 1 = Fault log triggered when MON11 is above/below the early threshold warning |
|  |  | [3] | 1 = Fault log triggered when MON12 is above/below the early threshold warning |
|  |  | [4] | 1 = Fault log triggered when overcurrent early threshold is exceeded |
|  |  | [5] | Reserved, must be set to ' 1 ' |
|  |  | [7:6] | Reserved |

If a GPIO_ is configured as an open-drain EXTFAULT input/output, and EXTFAULT is pulled low by an external circuit, bit r1Ch[5] is set.
The SMB Alert bit is set if the MAX16070/MAX16071 have asserted the SMBus Alert output. Clear by writing a '1'. See SMBALERT section for more details.

## Critical Faults

During normal operation, a fault condition can be configured to store fault information in the flash memory by setting the appropriate critical fault enable bits. Set the appropriate critical fault enable bits in registers r6Eh to r72h (see Table 14) for a fault condition to trigger a critical fault.

Logged fault information is stored in flash registers r200h to r20Fh (see Table 15). After fault information is logged, the flash is locked and must be unlocked to enable a new fault log to be stored. Write a '0' to r8Ch[1] to unlock the fault flash. Fault information can be configured to store ADC conversion results and/or fault flags in registers. Select the critical fault configuration in r6Dh[1:0]. Set r6Dh[1:0] to '11' to turn off the fault logger. All stored ADC results are 8 bits wide.

## Table 15. Nonvolatile Fault Log Registers

| www.D | taELASHADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
|  | 200h | - | Reserved |
|  |  | [0] | Fault log triggered on MON1 |
|  |  | [1] | Fault log triggered on MON2 |
|  |  | [2] | Fault log triggered on MON3 |
|  | 201h | [3] | Fault log triggered on MON4 |
|  |  | [4] | Fault log triggered on MON5 |
|  |  | [5] | Fault log triggered on MON6 |
|  |  | [6] | Fault log triggered on MON7 |
|  |  | [7] | Fault log triggered on MON8 |
|  |  | [0] | Fault log triggered on MON9 |
|  |  | [1] | Fault log triggered on MON10 |
|  |  | [2] | Fault log triggered on MON11 |
|  | $202 h$ | [3] | Fault log triggered on MON12 |
|  |  | [4] | Fault log triggered on overcurrent |
|  |  | [5] | Fault log triggered on EXTFAULT |
|  |  | [7:6] | Not used |

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

Table 15. Nonvolatile Fault Log Registers (continued)

| FLASH ADDRESS | BIT RANGE |  |
| :---: | :---: | :--- |
| 203 h | $[7: 0]$ | MON1 ADC output |
| 204 h | $[7: 0]$ | MON2 ADC output |
| 205 h | $[7: 0]$ | MON3 ADC output |
| 206 h | $[7: 0]$ | MON4 ADC output |
| 207 h | $[7: 0]$ | MON5 ADC output |
| 208 h | $[7: 0]$ | MON6 ADC output |
| 209 h | $[7: 0]$ | MON7 ADC output |
| 20 Ah | $[7: 0]$ | MON8 ADC output |
| 20 Bh | $[7: 0]$ | MON9 ADC output |
| 20 Ch | $[7: 0]$ | MON10 ADC output |
| 20 hh | $[7: 0]$ | MON11 ADC output |
| $20 E \mathrm{~h}$ | $[7: 0]$ | MON12 ADC output |
| 20 Fh | $[7: 0]$ | Current-sense ADC output |

Reset Output
The reset output, RESET, indicates the status of the monitored inputs.
During normal monitoring, RESET can be configured to assert when any combination of MON_ inputs violates configurable combinations of thresholds: undervoltage, overvoltage, or early warning. Select the combination of thresholds using r3Bh[1:0], and select the combination of MON_ inputs using rCh[7:1] and r3Dh[4:0]. Note that MON inputs configured as critical faults will always cause RESET to ássert regardless of these configuration bits.
RESET can be configured as push-pull or open drain using $\mathrm{r} 3 \mathrm{Bh}[3]$, and active-high or active-low using r3Bh[2]. Select the reset timeout by loading a value from Table 16 into r3Bh[7:4]. RESET can be forced to assert by writing a ' 1 ' into r3Ch[0]. RESET remains asserted for the reset timeout period after a ' 0 ' is written into r3Ch[0]. See Table 16. The current state of RESET can be checked by reading r20h[0].

## Watchdog Timer

The watchdog timer operates together with or independently of the MAX16070/MAX16071. When operating in dependent mode, the watchdog is not activated until EN goes high and RESET is deasserted. When operating in
independent mode, the watchdog timer activates immediately after VCC exceeds the UVLO threshold and the boot phase is complete. Set r73h[4] to ' 0 ' to configure the watchdog in dependent mode. Set r73h[4] to ' 1 ' to configure the watchdog in independent mode. See Table 17 for more information on configuring the watchdog timer in dependent or independent mode.

## Dependent Watchdog Timer Operation

Use the watchdog timer to monitor $\mu \mathrm{P}$ activity in two modes. Flexible timeout architecture provides an adjustable watchdog startup delay of up to 300 s, allowing complicated systems to complete lengthy boot-up routines. An adjustable watchdog timeout allows the supervisor to provide quick alerts when processor activity fails. After each reset event (VCC drops below UVLO then returns above UVLO, software reboot, manual reset $(\overline{\mathrm{MR}})$, EN input going low then high, or watchdog reset), the watchdog startup delay provides an extended time for the system to power up and fully initialize all $\mu \mathrm{P}$ and system components before assuming responsibility for routine watchdog updates. Set r76h[6:4] to a value other than ' 000 ' to enable the watchdog startup delay. Set r76h[6:4] to '000' to disable the watchdog startup delay.

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Table 16. Reset Output Configuration


# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

| REGISTER <br> ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 73h | 273h | [4] | $\begin{aligned} & \hline 1 \text { = Independent mode } \\ & 0=\text { Dependent mode } \\ & \hline \end{aligned}$ |
|  |  | [7] | 1 = Watchdog affects RESET output <br> $0=$ Watchdog does not affect RESET output |
|  |  | [6:4] | Watchdog startup delay $000=$ No initial timeout $001=30 \mathrm{~s}$ $010=40 \mathrm{~s}$ $011=80 \mathrm{~s}$ $100=120 \mathrm{~s}$ $101=160 \mathrm{~s}$ $110=220 \mathrm{~s}$ $111=300 \mathrm{~s}$ |
| 76h | 276h | [3:0] | $\begin{aligned} & \text { Watchdog timeout } \\ & 0000=\text { Watchdog disabled } \\ & 0001=1 \mathrm{~ms} \\ & 0010=2 \mathrm{~ms} \\ & 0011=4 \mathrm{~ms} \\ & 0100=8 \mathrm{~ms} \\ & 0101=14 \mathrm{~ms} \\ & 0110=27 \mathrm{~ms} \\ & 0111=50 \mathrm{~ms} \\ & 1000=100 \mathrm{~ms} \\ & 1001=200 \mathrm{~ms} \\ & 1010=400 \mathrm{~ms} \\ & 1011=750 \mathrm{~ms} \\ & 1100=1.4 \mathrm{~s} \\ & 1101=2.7 \mathrm{~s} \\ & 1110=5 \mathrm{~s} \\ & 1111=10 \mathrm{~s} \end{aligned}$ |

The normal watchdog timeout period, tWDI, begins after the first transition on WDI before the conclusion of the long startup watchdog period, twDI_STARTUP (Figure 5). During the normal operating mode, $\overline{W D O}$ asserts if the $\mu \mathrm{P}$ does not toggle WDI with a valid transition (high-tolow or low-to-high) within the standard timeout period, tWDI. $\overline{W D O}$ remains asserted until WDI is toggled or RESET is asserted (Figure 6).
While EN is low, the watchdog timer is in reset. The watchdog timer does not begin counting until RESET is deasserted. The watchdog timer is reset and $\overline{\mathrm{WDO}}$ deasserts any time RESET is asserted (Figure 7). The watchdog timer will be held in reset while RESET is asserted.

The watchdog can be configured to control the RESET output as well as the $\overline{\mathrm{WDO}}$ output. RESET asserts for the reset timeout, tRP, when the watchdog timer expires and the Watchdog Reset Output Enable bit (r76h[7]) is set to ' 1 .' When RESET is asserted, the watchdog timer is cleared and $\overline{\mathrm{WDO}}$ is deasserted, therefore, $\overline{\mathrm{WDO}}$ pulses low for a short time (approximately $1 \mu \mathrm{~s}$ ) when the watchdog timer expires. RESET is not affected by the watchdog timer when the Watchdog Reset Output Enable bit (r76h[7]) is set to '0.' If a RESET is asserted by the watchdog timeout, the WDRESET bit is set to ' 1 '. A connected processor can check this bit to see the reset was due to a watchdog timeout. See Table 17 for more information on configuring watchdog functionality.

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers



Figure 5. Normal Watchdog Startup Sequence

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Figure 6. Watchdog Timer Operation


Figure 7. Watchdog Startup Sequence with Watchdog Reset Enable Bit Set to '1'

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

## Independent Watchdog Timer Operation

When r73h[3] is ' 1 ' the watchdog timer operates in the independent mode. In the independent mode, the watchdog timer operates as if it were a separate device. The watchdog timer is activated immediately upon VCC exceeding UVLO and once the boot-up sequence is finished. When RESET is asserted, the watchdog timer and WDO are not affected.
There will be a startup delay if $\mathrm{r} 76 \mathrm{~h}[6: 4]$ is set to a value different than '000.' If $\mathrm{r} 76 \mathrm{~h}[6: 4]$ is set to ' 000 ,' there will not be a startup delay. See Table 17 for delay times.
In independent mode, if the Watchdog Reset Output Enable bit $\mathrm{r76h}[7]$ is set to ' 1 ,' when the watchdog timer expires, WDO asserts then RESET asserts. $\overline{\text { WDO }}$ will then deassert. WDO will be low for approximately $1 \mu \mathrm{~s}$. If the Watchdog Reset Output Enable bit (r76h[7]) is set to '0,' when the WDT expires, $\overline{W D O}$ asserts but RESET is not affected.

## User-Defined Register

Register r8Ah provides storage space for a user-defined configuration or firmware version number. Note that this register controls the contents of the JTAG USERCODE register bits 7:0. The user-defined register is stored at r28Ah in the flash memory.

## Memory Lock Bits

Register r8Ch contains the lock bits for the configuration registers, configuration flash, user flash, and fault register lock. See Table 18 for details.
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## SMBus-Compatible Interface

The MAX16070/MAX16071 feature an SMBuscompatible, 2 -wire serial interface consisting of a serialdata line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate bidirectional communication between the MAX16070/MAX16071 and the master device at clock rates up to 400 kHz . Figure 1 shows the 2 -wire interface timing diagram. The MAX16070/MAX16071 are transmit/ receive slave-only devices, relying upon a master device to generate a clock signal. The master device (typically a microcontroller) initiates a data transfer on the bus and generates SCL to permit that transfer.
A master device communicates to the MAX16070/ MAX16071 by transmitting the proper address followed by a command and/or data words. The slave address input, AO, is capable of detecting four different states, allowing multiple identical devices to share the same serial bus. The slave address is described further in the Slave Address section. Each transmit sequence is framed by a START (S) or REPEATED START (SR) condition and a STOP (P) condition. Each word transmitted over the bus is 8 bits long and is always followed by an acknowledge pulse. SCL is a logic input, while SDA is an open-drain input/output. SCL and SDA both require external pullup resistors to generate the logic-high voltage. Use $4.7 \mathrm{k} \Omega$ for most applications.

Table 18. Memory Lock Bits

| REGISTER ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 8Ch | 28 Ch | 0 | Configuration register lock $\begin{aligned} & 1=\text { Locked } \\ & 0=\text { Unlocked } \end{aligned}$ |
|  |  | 1 | Flash fault register lock $\begin{aligned} & 1=\text { Locked } \\ & 0=\text { Unlocked } \end{aligned}$ |
|  |  | 2 | Flash configuration lock $\begin{aligned} & 1=\text { Locked } \\ & 0=\text { Unlocked } \end{aligned}$ |
|  |  | 3 | User flash lock $\begin{aligned} & 1=\text { Locked } \\ & 0=\text { Unlocked } \end{aligned}$ |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers



Figure 8. Bit Transfer

## Bit Transfer

Each clock pulse transfers one data bit. The data on SDA must remain stable while SCL is high (Figure 8); otherwise the MAX16070/MAX16071 register a START or STOP condition (Figure 9) from the master. SDA and SCL idle high when the bus is not busy.

## START and STOP Conditions

Both SCL and SDA idle high when the bus is not busy. A master device signals the beginning of a transmission with a START condition by transitioning SDA from high to low while SCL is high. The master device issues a STOP condition by transitioning SDA from low to high while
www.DSCL的thiligh. A A STOP condition frees the bus for another transmission. The bus remains active if a REPEATED START condition is generated, such as in the block read protocol (see Figure 1).

Early STOP Conditions The MAX16070/MAX16071 recognize a STOP condition at any point during transmission except if a STOP condition occurs in the same high pulse as a START condition. This condition is not a legal SMBus format; at least one clock pulse must separate any START and STOP condition.

REPEATED START Conditions
A REPEATED START can be sent instead of a STOP condition to maintain control of the bus during a read operation. The START and REPEATED START conditions are functionally identical.


Figure 9. START and STOP Conditions

Acknowledge
The acknowledge bit (ACK) is the 9th bit attached to any 8 -bit data word. The receiving device always generates an ACK. The MAX16070/MAX16071 generate an ACK when receiving an address or data by pulling SDA low during the 9th clock period (Figure 11). When transmitting data, such as when the master device reads data back from the MAX16070/MAX16071, the device waits for the master device to generate an ACK. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if the receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master can reattempt communication at a later time. The MAX16070/MAX16071 generate a NACK after the command byte received during a software reboot, while writing to the flash, or when receiving an illegal memory address.

## Slave Address

Use the slave address input, AO, to allow multiple identical devices to share the same serial bus. Connect AO to GND, DBP (or an external supply voltage greater than $2 \mathrm{~V})$, SCL, or SDA to set the device address on the bus. See Table 20 for a listing of all possible 7-bit addresses.
The slave address can also be set to a custom value by loading the address into register r8Bh[6:0]. See Table 19. If $\mathrm{r} 8 \mathrm{Bh}[6: 0]$ is loaded with 00 h , the address is set by input AO. Do not set the address to 09h or 7Fh to avoid address conflicts. The slave address setting takes effect immediately after writing to the register.

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 



Figure 10. Acknowledge

Table 19. SMBus Settings Register

| REGISTER <br> ADDRESS | FLASH ADDRESS | BIT RANGE | DESCRIPTION |
| :--- | :---: | :---: | :--- |
| www.DataSheet48B九mm | 28 Bh | $[6: 0]$ | $I^{2} \mathrm{C}$ Slave Address Register. Set to 00h to use A0 pin <br> address setting. |
|  |  | $[7]$ | $1=$ Enable PEC (packet error check). |

Table 20. Setting the SMBus Slave Address

| SLAVE ADDRESSES |  |
| :---: | :---: |
| A0 | SLAVE ADDRESS |
| 0 | 1010 000R |
| 1 | 1010001 R |
| SCL | 1010010 R |
| SDA | 1010011 R |

$R=$ Read/Write select bit

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

Packet Error Checking (PEC)
The MAX16070/MAX16071 feature a PEC mode that is useful for improving the reliability of the communication bus by detecting bit errors. By enabling PEC, an extra CRC-8 error check byte is added in the data string during each read and/or write sequence. Enable PEC by writing a ' 1 ' to r8Bh[7].
The CRC-8 byte is calculated using the polynomial $C=X^{8}+X^{2}+X+1$
The PEC calculation includes all bytes in the transmission, including address, command, and data. The PEC calculation does not include ACK, NACK, START, STOP, or REPEATED START.

## Command Codes

The MAX16070/MAX16071 use eight command codes for block read, block write, and other commands. See Table 21 for a list of command codes.
To initiate a software reboot, send A7h using the send byte format. A software-initiated reboot is functionally the same as a hardware-initiated power-on reset. During boot-up, flash configuration data in the range of 230 h to 28 Ch is copied to r30h to r8Ch registers in the default page.
Send command code A8h to trigger a fault store to flash. Configure the Critical Fault Log Control register (6Dh) to store ADC conversion results and/or fault flags.
While in the flash page, send command code A9h to access the flash page (addresses from 200h to 28Fh). Once command code A9h has been sent, all addresses are recognized as flash addresses only. Send command code AAh to return to the default page (addresses from OOOh to OFFh). Send command code ABh to access the user flash-page (addresses from 300h to 3A4h and 3ADh-3ffh), and send command code ACh to return to the flash page.

## Restrictions When Writing to Flash

Flash must be written to 8 bytes at a time. The initial address must be aligned to 8 -byte boundaries-the three LSBs of the initial address must be '000.' Write the 8 bytes using a single block-write command or using 8 successive Write Byte commands.

Send Byte
The send byte protocol allows the master device to send one byte of data to the slave device (see Figure 11). The send byte presets a register pointer address for a subsequent read or write. The slave sends a NACK instead of an ACK if the master tries to send a memory address or command code that is not allowed. If the master sends A5h or A6h, the data is ACK, because this could be the start of the write block or read block. If the master sends a STOP condition before the slave asserts an ACK, the internal address pointer does not change. If the master sends A7h, this signifies a software reboot. The send byte procedure is the following:

1) The master sends a START condition.
2) The master sends the 7 -bit slave address and a write bit (low).
3) The addressed slave asserts an ACK on SDA.
4) The master sends an 8-bit memory address or command code.
5) The addressed slave asserts an ACK (or NACK) on SDA.
6) The master sends a STOP condition.

Table 21. Command Codes

| COMMAND <br> CODE |  |
| :---: | :--- |
| A5h | Block write |
| A6h | Block read |
| A7h | Reboot flash in register file |
| A8h | Trigger emergency save to flash |
| A9h | Flash page access ON |
| AAh | Flash page access OFF |
| ABh | User flash access ON (must be in flash page already) |
| ACh | User flash access OFF (return to flash page) |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Send Byte Format

| $S$ | ADDRESS | R $\bar{W}$ | ACK | COMMAND | ACK | $P$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\downarrow$ | 7 bits | 0 | 0 | 8 bits | 0 | $\mathbf{4}$ |
| Slave Address: Address <br> of the slave on the serial <br> interface bus. |  |  |  |  | Data Byte: Presets the internal <br> address pointer or represents <br> a command. |  |

Receive Byte Format

| S | ADDRESS | R/W | ACK | DATA | NACK | $P$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\downarrow$ | 7 bits | 1 | 0 | 8 bits | 1 | A |


| Slave Address: Address |
| :--- |
| of the slave on the serial |
| interface bus. | | Data Byte: Data is read from |
| :--- |
| the location pointed to by the |
| internal address pointer. |

Write Byte Format

| S | ADDRESS | R/W | ACK | COMMAND | ACK | DATA | ACK | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\downarrow$ | 7 bits | 0 | 0 | 8 bits | 0 | 8 bits | 0 | 4 |
| Slave Address: Address of the slave on the serial interface bus. |  |  |  | Command Byte: Sets the internal address pointer. |  | Data Byte: Data is written to the locations set by the internal address pointer. |  |  |

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| $S$ | ADDRESS | R $\bar{W}$ | ACK | DATA | NACK | $P$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\boldsymbol{\searrow}$ | 0001100 | D.C. | 0 | 8 bits | 1 | $\boldsymbol{4}$ |

interface bus. address pointer. internal addre by the

## Read Byte Forma

| COMMAND | ACK | SR | $\begin{gathered} \text { SLAVE } \\ \text { ADDRESS } \\ \hline \end{gathered}$ | R $\bar{W}$ | ACK | DATA BYTE | NACK | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 8 bits | 0 | $\downarrow$ | 7 bits | 1 | 0 | 8 bits | 1 | 4 |
| Command Byte: Data Byte: Data is written to <br> Sets the internal the locations set by the <br> address pointer. internal address pointer. |  |  |  |  |  |  |  |  |

Block Write Format

| S | ADDRESS | $\mathrm{R} / \overline{\mathrm{N}}$ | ACK | COMMAND | ACK | BYTE <br> COUNT $=\mathrm{N}$ | ACK | DATA BYTE 1 | ACK | DATA BYTE $\ldots$ | ACK | DATA BYTE $N$ | ACK | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\boldsymbol{\downarrow}$ | 7 bits | 0 | 0 | 8 bits | 0 | 8 bits | 0 | 8 bits | 0 | 8 bits | 0 | 8 bits | 0 | $\mathbf{4}$ |

Slave Address:
of the slave on the
serial interface bus.
Data Byte: Data is written to the locations
set by the internal address pointer

## Block Read Format

| S | ADDRESS | R/W | ACK | COMMAND | ACK | SR | ADDRESS | R/ $\bar{W}$ | ACK | $\begin{gathered} \text { BYTE } \\ \text { COUNT }=\mathrm{N} \end{gathered}$ | ACK | DATA BYTE N | ACK | DATA BYTE | ACK | DATA BYTE N | NACK | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\downarrow$ | 7 bits | 0 | 0 | 8 bits | 0 | $\downarrow$ | 7 bits | 1 | 0 | 8 bits | 0 | 8 bits | 0 | 8 bits | 0 | 8 bits | 1 | 4 |
|  | Slave Address: Address of the slave on the serial interface bus. |  |  | Command Byte: FBh |  |  | Slave Address: Address of the slave on the serial interface bus. |  |  | Data Byte: Data is read from the locations set by the internal address pointer. |  |  |  |  |  |  |  |  |

Write Byte Format with PEC

| S | ADDRESS | $\mathrm{R} \bar{W}$ | A | COMMAND | A | DATA | A | PEC | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\downarrow$ | 7 BITS | 0 | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | $\mathbf{4}$ |

## Read Byte Format with PEC

| S | ADDRESS | R $\bar{W}$ | A | COMMAND | A | SR | ADDRESS | R $\bar{M}$ | A | DATA | A | PEC | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\boldsymbol{\downarrow}$ | 7 BITS | 0 | 0 | 8 BITS | 0 | $\boldsymbol{\downarrow}$ | 7 BITS | 1 | 0 | 8 BITS | 0 | 8 BITS | 0 | 4 |

Block Write with PEC

| S | ADDRESS | R $\bar{N}$ | A | COMMAND | A | BYTE COUNT N | A | DATA BYTE 1 | A | DATA BYTE | A | DATAN | A | PEC | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\boldsymbol{\downarrow}$ | 7 BITS | 0 | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | 4 |

Block Read with PEC

| S | ADDRESS | R $\bar{N}$ | A | COMMAND | A | SR | ADDRESS | R $\bar{W}$ | A | BYTE COUNT N | A | DATA BYTE 1 | A | DATA BYTE | A | DATA | A | PEC | N |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\boldsymbol{P}$ |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\boldsymbol{\downarrow}$ | 7 BITS | 0 | 0 | 8 BITS | 0 | $\boldsymbol{\downarrow}$ | 7 BITS | 1 | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | 0 | 8 BITS | P |

[^1]ACK = Acknowledge, SDA pulled low during rising edge of SCL. NACK = Not acknowledge, SDA left high during rising edge of SCL.
All data is clocked in/out of the device on rising edges of SCL.
$\boldsymbol{\downarrow}=$ SDA transitions from high to low during period of SCL.
$4=$ SDA transitions from low to high during period of SCL.

Figure 11. SMBus Protocols

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

The receive byte protocol allows the master device to read the register content of the MAX16070/MAX16071 (see Figure 11). The flash or register address must be preset with a send byte or write word protocol first. Once the read is complete, the internal pointer increases by one. Repeating the receive byte protocol reads the contents of the next address. The receive byte procedure follows:

1) The master sends a START condition.
2) The master sends the 7 -bit slave address and a read bit (high).
3) The addressed slave asserts an ACK on SDA.
4) The slave sends 8 data bits.

5 The master asserts a NACK on SDA.
6) The master generates a STOP condition.

## Write Byte

The write byte protocol (see Figure 11) allows the master device to write a single byte in the default page, extended page, or flash page, depending on which page is currently selected. The write byte procedure is the following:

1) The master sends a START condition.
2) The master sends the 7-bit slave address and a write bit (low).
3) The addressed slave asserts an ACK on SDA.
4) The master sends an 8-bit memory address.
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5) The master sends an 8-bit data byte.
6) The addressed slave asserts an ACK on SDA.
7) The master sends a STOP condition.

To write a single byte, only the 8-bit memory address and a single 8 -bit data byte are sent. The data byte is written to the addressed location if the memory address is valid. The slave asserts a NACK at step 5 if the memory address is not valid.
When PEC is enabled, the Write Byte protocol becomes:

1) The master sends a START condition.
2) The master sends the 7-bit slave ID plus a write bit (low).
3) The addressed slave asserts an ACK on the data line.
4) The master sends an 8-bit command code.
5) The active slave asserts an ACK on the data line.
6) The master sends an 8-bit data byte.
7) The slave asserts an ACK on the data line.
8) The master sends an 8-bit PEC byte.
9) The slave asserts an ACK on the data line (if PEC is good, otherwise NACK).
10) The master generates a STOP condition.

Read Byte
The read byte protocol (see Figure 11) allows the master device to read a single byte located in the default page, extended page, or flash page depending on which page is currently selected. The read byte procedure is the following:

1) The master sends a START condition.
2) The master sends the 7-bit slave address and a write bit (low).
3) The addressed slave asserts an ACK on SDA.
4) The master sends an 8-bit memory address.
5) The addressed slave asserts an ACK on SDA.
6) The master sends a REPEATED START condition.
7) The master sends the 7-bit slave address and a read bit (high).
8) The addressed slave asserts an ACK on SDA.
9) The slave sends an 8-bit data byte.
10) The master asserts a NACK on SDA.
11) The master sends a STOP condition.

If the memory address is not valid, it is NACKed by the slave at step 5 and the address pointer is not modified.
When PEC is enabled, the Read Byte protocol becomes:

1) The master sends a START condition.
2) The master sends the 7-bit slave ID plus a write bit (low).
3) The addressed slave asserts an ACK on the data line.
4) The master sends 8 data bits.
5) The active slave asserts an ACK on the data line.
6) The master sends a REPEATED START condition.
7) The master sends the 7-bit slave ID plus a read bit (high).
8) The addressed slave asserts an ACK on the data line.
9) The slave sends 8 data bits.
10) The master asserts an ACK on the data line.
11) The slave sends an 8-bit PEC byte.
12) The master asserts a NACK on the data line.
13) The master generates a STOP condition.

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The block write protocol (see Figure 11) allows the master device to write a block of data ( 1 byte to 16 bytes) to memory. Preload the destination address by a previous send byte command; otherwise the block write command begins to write at the current address pointer. After the last byte is written, the address pointer remains preset to the next valid address. If the number of bytes to be written causes the address pointer to exceed 8Fh for configuration registers or configuration flash or FFh for user flash, the address pointer stays at 8Fh or FFh, respectively, overwriting this memory address with the remaining bytes of data. The slave generates a NACK at step 5 if the command code is invalid or if the device is busy, and the address pointer is not altered.
The block write procedure is the following:

1) The master sends a START condition.
2) The master sends the 7 -bit slave address and a write bit (low).
3) The addressed slave asserts an ACK on SDA.
4) The master sends the 8-bit command code for block write (94h).
5) The addressed slave asserts an ACK on SDA.
6) The master sends the 8 -bit byte count ( 1 byte to 16 bytes), n .
7) The addressed slave asserts an ACK on SDA.
8) The master sends 8 bits of data.
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9) The addressed slave asserts an ACK on SDA.
10) Repeat steps 8 and $9 n-1$ times.
11) The master sends a STOP condition.

When PEC is enabled, the Block Write protocol becomes:

1) The master sends a START condition.
2) The master sends the 7-bit slave ID plus a write bit (low).
3) The addressed slave asserts an ACK on the data line.
4) The master sends 8 bits of the block write command code.
5) The slave asserts an ACK on the data line.
6) The master sends an 8-bit byte count (min 1, max 16), n.
7) The slave asserts an ACK on the data line.
8) The master sends 8 bits of data.
9) The slave asserts an ACK on the data line.
10) Repeat 8 and $9 n-1$ times.
11) The master sends an 8 -bit PEC byte.
12) The slave asserts an ACK on the data line (if PEC is good, otherwise NACK).
13) The master generates a STOP condition.

## Block Read

The block read protocol (see Figure 11) allows the master device to read a block of up to 16 bytes from memory. Read fewer than 16 bytes of data by issuing an early STOP condition from the master, or by generating a NACK with the master. The destination address should be preloaded by a previous send byte command; otherwise the block read command begins to read at the current address pointer. If the number of bytes to be read causes the address pointer to exceed 8 Fh for the configuration register or configuration flash or FFh in user flash, the address pointer stays at 8Fh or FFh, respectively. The block read procedure is the following:

1) The master sends a START condition.
2) The master sends the 7 -bit slave address and a write bit (low).
3) The addressed slave asserts an ACK on SDA.
4) The master sends 8 bits of the block read command (95h).
5) The slave asserts an ACK on SDA, unless busy.
6) The master generates a REPEATED START condition.
7) The master sends the 7 -bit slave address and a read bit (high).
8) The slave asserts an ACK on SDA.
9) The slave sends the 8 -bit byte count (16).
10) The master asserts an ACK on SDA.
11) The slave sends 8 bits of data.
12) The master asserts an ACK on SDA.
13) Repeat steps 11 and 12 up to fifteen times.
14) The master asserts a NACK on SDA.
15) The master sends a STOP condition.

When PEC is enabled, the Block Read protocol becomes:

1) The master sends a START condition.
2) The master sends the 7 -bit slave ID plus a write bit (low).

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Table 22. SMBus Alert Configuration

| REGISTER <br> ADDRESS | FLASH <br> ADDRESS | BIT RANGE | DESCRIPTION |
| :---: | :---: | :---: | :--- |
|  |  |  | SMBus Alert Configuration <br> $00=$ Disabled <br> $05 h$ |
|  | 235 h | $[1: 0]$ | $01=$ Fault is SMBus $\overline{\text { ALERT }}$ <br> $10=$ Fault2 is SMBus $\overline{\text { ALERT }}$ <br> $11=\overline{\text { Any_Fault is SMBus } \overline{\text { ALERT }}}$ |

3) The addressed slave asserts an ACK on the data line.
4) The master sends 8 bits of the block read command code.
5) The slave asserts an ACK on the data line unless busy.
6) The master sends a REPEATED START condition.
7) The master sends the 7 -bit slave ID plus a read bit (high).
8) The slave asserts an ACK on the data line.
9) The slave sends an 8-bit byte count (16).
10) The master asserts an ACK on the data line.
11) The slave sends 8 bits of data.
12) The master asserts an ACK on the data line.
13) Repeat steps 11 and 12 up to 15 times.
14) The slave sends an 8-bit PEC byte.
15) The master asserts a NACK on the data line.


SMBALERT
The MAX16070/MAX16071 support the SMBus alert protocol. To enable the SMBus alert output, set r35h[1:0] according to Table 22, which configures a Fault1, Fault2, or Any_Fault output to act as the SMBus alert. This output is open-drain and uses the wired-OR configuration with other devices on the SMBus. During a fault, the MAX16070/MAX16071 assert ALERT low, signaling the master that an interrupt has occurred. The master responds by sending the ARA (Alert Response Address) protocol on the SMBus. This protocol is a read byte with 09 h as the slave address. The slave acknowledges the ARA (09h) address and sends its own SMBus address to the master. The slave then deasserts ALERT. The master can then query the slave and determine the cause of the fault. By checking $\mathrm{r} 1 \mathrm{C}[6]$, the master can confirm that the MAX16070/MAX16071 triggered the SMBus alert. The master must send the ARA before clearing r1Ch[6]. Clear r1Ch[6] by writing a ' 1 '.

## JTAG Serial Interface

The MAX16070/MAX16071 feature a JTAG port that complies with a subset of the IEEE 1149.1 specification. Either the SMBus or the JTAG interface can be used to access internal memory; however, only one interface is allowed to run at a time. The MAX16070/MAX16071 do not support IEEE 1149.1 boundary-scan functionality. The MAX16070/MAX16071 contain extra JTAG instructions and registers not included in the JTAG specification that provide access to internal memory. The extra instructions include LOAD ADDRESS, WRITE, READ, REBOOT, SAVE.

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Figure 12. JTAG Block Diagram

## Test Access Port (TAP) Controller State Machine

 The TAP controller is a finite state machine that responds to the logic level at TMS on the rising edge of TCK. See Figure 13 for a diagram of the finite state machine. The possible states are described in the following:Test-Logic-Reset: At power-up, the TAP controller is in the test-logic-reset state. The instruction register contains the IDCODE instruction. All system logic of the device operates normally. This state can be reached from any state by driving TMS high for five clock cycles.

Run-Test/Idle: The run-test/idle state is used between scan operations or during specific tests. The instruction register and test data registers remain idle.
Select-DR-Scan: All test data registers retain their previous state. With TMS low, a rising edge of TCK moves the controller into the capture-DR state and initiates a scan sequence. TMS high during a rising edge on TCK moves the controller to the select-IR-scan state.

Capture-DR: Data can be parallel-loaded into the test data registers selected by the current instruction. If the instruction does not call for a parallel load or the selected test data register does not allow parallel loads, the test

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Figure 13. Tap Controller State Diagram
data register remains at its current value. On the rising edge of TCK, the controller goes to the shift-DR state if TMS is low or it goes to the exit1-DR state if TMS is high.
Shift-DR: The test data register selected by the current
www.Dinstrtection coonnects between TDI and TDO and shifts data one stage toward its serial output on each rising edge of TCK while TMS is low. On the rising edge of TCK, the controller goes to the exit1-DR state if TMS is high.

Exit1-DR: While in this state, a rising edge on TCK puts the controller in the update-DR state. A rising edge on TCK with TMS low puts the controller in the pause-DR state.
Pause-DR: Shifting of the test data registers halts while in this state. All test data registers retain their previous state. The controller remains in this state while TMS is low. A rising edge on TCK with TMS high puts the controller in the exit2-DR state.
Exit2-DR: A rising edge on TCK with TMS high while in this state puts the controller in the update-DR state. A rising edge on TCK with TMS low enters the shift-DR state.
Update-DR: A falling edge on TCK while in the updateDR state latches the data from the shift register path of the test data registers into a set of output latches. This prevents changes at the parallel output because of changes in the shift register. On the rising edge of TCK,
the controller goes to the run-test/idle state if TMS is low or goes to the select-DR-scan state if TMS is high.
Select-IR-Scan: All test data registers retain the previous states. The instruction register remains unchanged during this state. With TMS low, a rising edge on TCK moves the controller into the capture-IR state. TMS high during a rising edge on TCK puts the controller back into the test-logic-reset state.

Capture-IR: Use the capture-IR state to load the shift register in the instruction register with a fixed value. This value is loaded on the rising edge of TCK. If TMS is high on the rising edge of TCK, the controller enters the exit1IR state. If TMS is low on the rising edge of TCK, the controller enters the shift-IR state.
Shift-IR: In this state, the shift register in the instruction register connects between TDI and TDO and shifts data one stage for every rising edge of TCK toward the TDO serial output while TMS is low. The parallel outputs of the instruction register as well as all test data registers remain at the previous states. A rising edge on TCK with TMS high moves the controller to the exit1-IR state. A rising edge on TCK with TMS low keeps the controller in the shift-IR state while moving data one stage through the instruction shift register.

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Exit1-IR: A rising edge on TCK with TMS low puts the controller in the pause-IR state. If TMS is high on the rising edge of TCK, the controller enters the update-IR state.
Pause-IR: Shifting of the instruction shift register halts temporarily. With TMS high, a rising edge on TCK puts the controller in the exit2-IR state. The controller remains in the pause-IR state if TMS is low during a rising edge on TCK.
Exit2-IR: A rising edge on TCK with TMS high puts the controller in the update-IR state. The controller loops back to shift-IR if TMS is low during a rising edge of TCK in this state.
Update-IR: The instruction code that has been shifted into the instruction shift register latches to the parallel outputs of the instruction register on the falling edge of TCK as the controller enters this state. Once latched, this instruction becomes the current instruction. A rising edge on TCK with TMS low puts the controller in the runtest/idle state. With TMS high, the controller enters the select-DR-scan state.

## Instruction Register

The instruction register contains a shift register as well as a latched 5 -bit-wide parallel output. When the TAP controller enters the shift-IR state, the instruction shift
register connects between TDI and TDO. While in the shift-IR state, a rising edge on TCK with TMS low shifts the data one stage toward the serial output at TDO. A rising edge on TCK in the exit1-IR state or the exit2-IR state with TMS high moves the controller to the updateIR state. The falling edge of that same TCK latches the data in the instruction shift register to the instruction register parallel output. Table 23 shows the instructions supported by the MAX16070/MAX16071 and the respective operational binary codes.
BYPASS: When the BYPASS instruction is latched into the instruction register, TDI connects to TDO through the 1-bit bypass test data register. This allows data to pass from TDI to TDO without affecting the device's operation.
IDCODE: When the IDCODE instruction is latched into the parallel instruction register, the identification data register is selected. The device identification code is loaded into the identification data register on the rising edge of TCK following entry into the capture-DR state. Shift-DR can be used to shift the identification code out serially through TDO. During test-logic-reset, the IDCODE instruction is forced into the instruction register. The identification code always has a ' 1 ' ' in the LSB position. The next 11 bits identify the manufacturer's JEDEC number and number of continuation bytes followed by 16 bits for the device and 4 bits for the version. See Table 24.

Table 23. JTAG Instruction Set

| www.D | INSTRUCTION | CODE | NOTES |
| :---: | :---: | :---: | :---: |
|  | BYPASS | 0x1F | Mandatory instruction code |
|  | IDCODE | 0x00 | Load manufacturer ID code/part number |
|  | USERCODE | 0x03 | Load user code |
|  | LOAD ADDRESS | 0x04 | Load address register content |
|  | READ DATA | $0 \times 05$ | Read data pointed by current address |
|  | WRITE DATA | $0 \times 06$ | Write data pointed by current address |
|  | REBOOT | 0x07 | Reboot FLASH data content into register file |
|  | SAVE | 0x08 | Trigger emergency save to flash |
|  | SETFLSHADD | 0x09 | Flash page access ON |
|  | RSTFLSHADD | 0x0A | Flash page access OFF |
|  | SETUSRFLSH | 0x0B | User flash access ON (must be in flash page already) |
|  | RSTUSRFLSH | 0x0C | User flash access OFF (return to flash page) |

Table 24. 32-Bit Identification Code

| MSB |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: |
|  | VERSION | PART NUMBER (16 BITS) | MANUFACTURER (11 BITS) | FIXED VALUE (1 BIT) |
| MAX16070 | REV | 1000000000000011 | 00011001011 | 1 |
| MAX16071 | REV | 1000000000000100 | 00011001011 | 1 |

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Table 25. 32-Bit User-Code Data


USERCODE: When the USERCODE instruction latches into the parallel instruction register, the user-code data register is selected. The device user-code loads into the user-code data register on the rising edge of TCK following entry into the capture-DR state. Shift-DR can be used to shift the user-code out serially through TDO. See Table 25. This instruction can be used to help identify multiple MAX16070/MAX16071 devices connected in a JTAG chain.
LOAD ADDRESS: This is an extension to the standard IEEE 1149.1 instruction set to support access to the memory in the MAX16070/MAX16071. When the LOAD ADDRESS instruction latches into the instruction register, TDI connects to TDO through the 8-bit memory address test data register during the shift-DR state.
READ DATA: This is an extension to the standard IEEE 1149.1 instruction set to support access to the memory in the MAX16070/MAX16071. When the READ instruction latches into the instruction register, TDI connects to TDO through the 8-bit memory read test data register during the shift-DR state.
WRITE DATA: This is an extension to the standard IEEE 1149.1 instruction set to support access to the memory in the MAX16070/MAX16071. When the WRITE instruction latches into the instruction register, TDI connects to TDO through the 8-bit memory write test data register during the shift-DR state.
REBOOT: This is an extension to the standard IEEE 1149.1 instruction set to initiate a software-controlled reset to the MAX16070/MAX16071. When the REBOOT instruction latches into the instruction register, the MAX16070/MAX16071 reset and immediately begin the boot-up sequence.
SAVE: This is an extension to the standard IEEE 1149.1 instruction set that triggers a fault log. The current ADC conversion results along with fault information are saved to flash depending on the configuration of the Critical Fault Log Control register (r6Dh).
SETFLSHADD: This is an extension to the standard IEEE 1149.1 instruction set that allows access to the flash page. Flash registers include ADC conversion results,

DACOUT enables, and GPIO_ input/output data. Use this page to access registers 200h to 2FFh
RSTFLSHADD: This is an extension to the standard IEEE 1149.1 instruction set. Use RSTFLSHADD to return to the default page and disable access to the flash page.
SETUSRFLSH: This is an extension to the standard IEEE 1149.1 instruction set that allows access to the user flash page. When on the configuration flash page, send the SETUSRFLSH command, all addresses are recognized as flash addresses only. Use this page to access registers 300h to 3FFh.
RSTUSRFLSH: This is an extension to the standard IEEE 1149.1 instruction set. Use RSTUSRFLSH to return to the configuration flash page and disable access to the user flash.

Restrictions When Writing to Flash Flash must be written to 8 bytes at a time. The initial address must be aligned to 8-byte boundaries-the 3 LSBs of the initial address must be '000'. Write the 8 bytes using eight successive Write Data commands.

## Applications Information

## Device Behavior at Power-Up

When VCC is ramped from 0 , the RESET output is high impedance until VCC reaches 1.4 V , at which point RESET goes low. All other outputs are high impedance until VCC reaches 2.7 V , when the flash contents are copied into register memory. This takes 150 $\mu$ (max), after which the outputs assume their programmed states.

## Maintaining Power During a Fault Condition

Power to the MAX16070/MAX16071 must be maintained for a specific period of time to ensure a successful flash fault log operation during a fault that removes power to the circuit. Table 26 shows the amount of time required depends on the settings in the fault control register (r6Dh[1:0]).
Maintain power for shutdown during fault conditions in applications where the always-on power supply cannot be relied upon by placing a diode and a large capacitor between the voltage source, VIN, and VCC (Figure 14).

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The capacitor value depends on $\mathrm{V}_{\mathrm{IN}}$ and the time delay required, tFAULT_SAVE. Use the following formula to calculate the capacitor size:
C = (tFAULT_SAVE $\times \operatorname{ICC}(M A X)) /(V I N-V D I O D E-V U V L O)$ where the capacitance is in Farads and tFAULT_SAVE is in seconds, ICC(MAX) is 14 mA , VDIODE is the voltage drop

Table 26. Maximum Write Time

| R6Dh[1:0] <br> VALUE | DESCRIPTION | MAXIMUM <br> WRITE TIME <br> (ms) |
| :---: | :--- | :---: |
| 00 | Save flags and ADC <br> readings | 153 |
| 01 | Save flags | 102 |
| 10 | Save ADC readings | 153 |
| 11 | Do not save anything | - |

across the diode, and VUVLO is 2.7 V . For example, with a VIN of 14 V , a diode drop of 0.7 V , and a tFAULT_SAVE of 153 ms , the minimum required capacitance is $202 \mu \mathrm{~F}$.


Figure 14. Power Circuit for Shutdown During Fault Conditions


Figure 15. Graphical User Interface Screenshot

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## Configuring the Device

An evaluation kit and a graphical user interface (GUI) is available to create a custom configuration for the device. Refer to the MAX16070/MAX16071 evaluation kit for configuration.

## Cascading Multiple MAX16070/MAX16071s

Multiple MAX16070/MAX16071s can be cascaded to increase the number of monitored rails. There are many ways to cascade the devices depending on the desired behavior. In general, there are several techniques:

- Configure a GPIO_ on each device to be EXTFAULT (open drain). Externally wire them together with a single pullup resistor. Set register bits r72h[5] and r6Dh[2] to ' 1 ' so that all faults will propagate between devices. If a critical fault occurs on one device, EXTFAULT will assert, triggering the nonvolatile fault logger in all cascaded devices and recording a snapshot of all system voltages.
- Connect open-drain RESET outputs together to obtain a master system reset signal.
- Connect all EN inputs together for a master enable signal.


## Monitoring Current Using the Differential Inputs

The MAX16070/MAX16071 can monitor up to seven currents using the dedicated current-sense amplifier as well as up to six pairs of inputs configured in differential www. Dmode the accuracy of the differential pairs is limited by the voltage range and the 10-bit conversions. Each input pair uses an odd-numbered MON_ input in combination with an even-numbered MON_ input to monitor both the voltage from the odd-numbered MON _ to ground and the voltage difference between the two MON_ inputs. This way a single pair of inputs can monitor the voltage and the current of a power-supply rail. The overvoltage threshold on the even numbered MON_ input can be used as an overcurrent flag.


Figure 16. Current Monitoring Connection

Figure 16 shows how to connect a current-sense resistor to a pair of MON_ inputs for monitoring both current and voltage.
For best accuracy, set the voltage range on the evennumbered MON_ to 1.4 V . Since the ADC conversion results are 10 bits, the monitoring precision is $1.4 / 1024$ $=1.4 \mathrm{mV}$. For more accurate current measurements, use larger current-sense resistors. The application requirements should determine the balance between accuracy and voltage drop across the current-sense resistor.

## Layout and Bypassing

Bypass DBP and ABP each with a $1 \mu \mathrm{~F}$ ceramic capacitor to GND. Bypass VCC with a $10 \mu \mathrm{~F}$ capacitor to ground. Avoid routing digital return currents through a sensitive analog area, such as an analog supply input return path or ABP's bypass capacitor ground connection. Use dedicated analog and digital ground planes. Connect the capacitors as close as possible to the device.

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| FLASH ADDRESS | REGISTER ADDRESS | READ/ WRITE | DESCRIPTION |  |
| :---: | :---: | :---: | :---: | :---: |
| ADC VALUES, FAULT REGISTERS, GPIO_S AS INPUT PORTS-NOT IN FLASH |  |  |  |  |
| - | 000 | R | MON1 ADC output, MSBs |  |
| - | 001 | R | MON1 ADC output, LSBs |  |
| - | 002 | R | MON2 ADC output, MSBs |  |
| - | 003 | R | MON2 ADC output, LSBs |  |
| - | 004 | R | MON3 ADC output, MSBs |  |
| - | 005 | R | MON3 ADC output, LSBs |  |
| - | 006 | R | MON4 ADC output, MSBs |  |
| - | 007 | R | MON4 ADC output, LSBs |  |
| - | 008 | R | MON5 ADC output, MSBs |  |
| - | 009 | R | MON5 ADC output, LSBs |  |
| - | 00A | R | MON6 ADC output, MSBs |  |
| - | 00B | R | MON6 ADC output, LSBs |  |
| - | OOC | R | MON7 ADC output, MSBs |  |
| - | OOD | R | MON7 ADC output, LSBs |  |
| - | OOE | R | MON8 ADC output, MSBs |  |
| - | 00F | R | MON8 ADC output, LSBs |  |
| - | 010 | R | MON9 ADC output, MSBs |  |
| - | 011 | R | MON9 ADC output, LSBs |  |
| - | 012 | R | MON10 ADC output, MSBs |  |
| - | 013 | R | MON10 ADC output, LSBs |  |
| - | 014 | R | MON11 ADC output, MSBs |  |
| 5hot4 | 015 | R | MON11 ADC output, LSBs |  |
| - | 016 | R | MON12 ADC output, MSBs |  |
| - | 017 | R | MON12 ADC output, LSBs |  |
| - | 018 | R | Current-sense ADC output |  |
| - | 019 | R | CSP ADC output, MSBs |  |
| - | 01A | R | CSP ADC output, LSBs |  |
| - | 01B | R/W | Fault register--failed line flags |  |
| - | 01C | R/W | Fault register-failed line flags/overcurrent |  |
| - | 01D | R | Reserved |  |
| - | 01E | R | GPIO data in (read only) |  |
| - | 01F | R | Reserved |  |
| - | 020 | R/W | Flash status/reset output monitor |  |
| - | 021 | R | Reserved |  |

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| FLASH ADDRESS | REGISTER ADDRESS | READ/ WRITE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| GPIO AND OUTPUT DEPENDENCIES/CONFIGURATIONS |  |  |  |
| 230 | 030 | R/W | Reserved |
| 231 | 031 | R/W | Reserved |
| 232 | 032 | R/W | Reserved |
| 233 | 033 | R/W | Reserved |
| 234 | 034 | R/W | Reserved |
| 235 | 035 | R/W | SMBALERT pin configuration |
| 236 | 036 | R/W | Fault1 dependencies |
| 237 | 037 | R/W | Fault1 dependencies |
| 238 | 038 | R/W | Fault2 dependencies |
| 239 | 039 | R/W | Fault2 dependencies |
| 23A | 03A | R/W | Fault1/Fault2 secondary overcurrent dependencies |
| 23B | 03B | R/W | RESET output configuration |
| 23C | 03C | R/W | RESET output dependencies |
| 23D | 03D | R/W | RESET output dependencies |
| 23E | 03E | R/W | GPIO data out |
| 23F | 03F | R/W | GPIO configuration |
| 240 | 040 | R/W | GPIO configuration |
| 241 | 041 | R/W | GPIO configuration |
| 242 | 042 | R/W | GPIO push-pull/open drain |
| ADC-CONVERSIONS |  |  |  |
| 243 | 043 | R/W | ADCs voltage ranges-MON_ monitoring |
| ataShe244 J.com | 044 | R/W | ADCs voltage ranges-MON_ monitoring |
| 245 | 045 | R/W | ADCs voltage ranges-MON_ monitoring |
| 246 | 046 | R/W | Differential pairs enables |
| 247 | 047 | R/W | Current-sense gain-setting (CSP, HV or LV) |
| INPUT THRESHOLDS |  |  |  |
| 248 | 048 | R/W | MON1 secondary selectable UV/OV |
| 249 | 049 | R/W | MON1 primary OV |
| 24A | 04A | R/W | MON1 primary UV |
| 24B | 04B | R/W | MON2 secondary selectable UV/OV |
| 24C | 04C | R/W | MON2 primary OV |
| 24D | 04D | R/W | MON2 primary UV |
| 24E | 04E | R/W | MON3 secondary selectable UV/OV |
| 24F | 04F | R/W | MON3 primary OV |
| 250 | 050 | R/W | MON3 primary UV |
| 251 | 051 | R/W | MON4 secondary selectable UV/OV |
| 252 | 052 | R/W | MON4 primary OV |
| 253 | 053 | R/W | MON4 primary UV |

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| FLASH ADDRESS | REGISTER ADDRESS | READ/ WRITE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 254 | 054 | R/W | MON5 secondary selectable UV/OV |
| 255 | 055 | R/W | MON5 primary OV |
| 256 | 056 | R/W | MON5 primary UV |
| 257 | 057 | R/W | MON6 secondary selectable UV/OV |
| 258 | 058 | R/W | MON6 primary OV |
| 259 | 059 | R/W | MON6 primary UV |
| 25A | 05A | R/W | MON7 secondary selectable UV/OV |
| 25B | 05B | R/W | MON7 primary OV |
| 25C | 05C | R/W | MON7 primary UV |
| 25D | 05D | R/W | MON8 secondary selectable UV/OV |
| 25E | 05E | R/W | MON8 primary OV |
| 25F | 05F | R/W | MON8 primary UV |
| 260 | 060 | R/W | MON9 secondary selectable UV/OV |
| 261 | 061 | R/W | MON9 primary OV |
| 262 | 062 | R/W | MON9 primary UV |
| 263 | 063 | R/W | MON10 secondary selectable UV/OV |
| 264 | 064 | R/W | MON10 primary OV |
| 265 | 065 | R/W | MON10 primary UV |
| 266 | 066 | R/W | MON11 secondary selectable UV/OV |
| 267 | 067 | R/W | MON11 primary OV |
| 268 | 068 | R/W | MON11 primary UV |
| 269 | 069 | R/W | MON12 secondary selectable UV/OV |
| taSh26A . com | 06A | R/W | MON12 primary OV |
| 26B | 06B | R/W | MON12 primary UV |
| 26C | 06C | R/W | Secondary overcurrent threshold |
| FAULT SETUP |  |  |  |
| 26D | 06D | R/W | Save after EXTFAULT fault control |
| 26 E | 06E | R/W | Faults causing store in flash |
| 26F | 06F | R/W | Faults causing store in flash |
| 270 | 070 | R/W | Faults causing store in flash |
| 271 | 071 | R/W | Faults causing store in flash |
| 272 | 072 | R/W | Faults causing store in flash |
| TIMEOUTS |  |  |  |
| 273 | 073 | R/W | Overcurrent debounce, watchdog mode, secondary threshold type, software enables |
| 274 | 074 | R/W | ADC fault deglitch configuration |
| 275 | 075 | R/W | WDI toggle |
| 276 | 076 | R/W | Watchdog reset output enable, watchdog timers |
| 277 | 077 | R/W | Boot-up delay |

## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Register Map (continued)

| FLASH <br> ADDRESS | REGISTER <br> ADDRESS |  |
| :---: | :---: | :---: |
| 278 | 078 |  |
| 279 | 079 |  |
| 27 A | 07 A |  |
| 27 B | 07 B |  |
| 27 C | 07 C |  |
| 27 D | 07 D |  |
| MISCELLANEOUS |  |  |


| 27 E | 07 E | $\mathrm{R} / \mathrm{W}$ | Reserved |
| :---: | :--- | :--- | :--- |
| 27 F | 07 F | $\mathrm{R} / \mathrm{W}$ | Reserved |
| 280 | 080 | $R / W$ | Reserved |
| 281 | 081 | $R / W$ | Reserved |
| 282 | 082 | $R / W$ | Reserved |
| 283 | 083 | $R / W$ | Reserved |
| 284 | 084 | $R / W$ | Reserved |
| 285 | 085 | $R / W$ | Reserved |
| 286 | 086 | $R / W$ | Reserved |
| 287 | 087 | $R / W$ | Reserved |
| 288 | 088 | $R / W$ | Reserved |
| 289 | 089 | $R / W$ | Reserved |
| 28 A | 08 A | $R / W$ | Customer use (version) |
| $28 B$ | $08 B$ | $R / W$ | PEC enable//2C address |
| 28 C | $08 C$ | $R / W$ | Lock bits |
| ataShe28D.com | $08 D$ | $R$ | Revision code |

NONVOLATILE FAULT LOG

| 200 | - | R/W | Reserved |
| :--- | :--- | :--- | :--- |
| 201 | - | R/W | FAULT flags, MON1-MON8 |
| 202 | - | R/W | FAULT flags, MON9-MON12, EXTFAULT |
| 203 | - | R/W | MON1 ADC output |
| 204 | - | R/W | MON2 ADC output |
| 205 | - | R/W | MON3 ADC output |
| 206 | - | R/W | MON4 ADC output |
| 207 | - | R/W | MON5 ADC output |
| 208 | - | R/W | MON6 ADC output |
| 209 | - | R/W | MON7 ADC output |
| $20 A$ | - | R/W | MON8 ADC output |
| $20 B$ | - | R/W | MON9 ADC output |
| $20 C$ | - | R/W | MON10 ADC output |
| $20 D$ | - | R/W | MON11 ADC output |
| $20 E$ | - | R/W | MON12 ADC output |
| $20 F$ | - | R/W | Current-sense ADC output |

# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 



## 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers

Typical Operating Circuits (continued)


# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 



# 12-Channel/8-Channel, Flash-Configurable System Managers with Nonvolatile Fault Registers 

## Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | DOCUMENT NO. |
| :---: | :---: | :---: |
| 40 TQFN-EP* | T4066-5 | $\underline{\mathbf{2 1 - 0 1 4 1}}$ |


[^0]:    Networking Equipment
    Telecom Equipment (Base Stations, Access)
    Storage/Raid Systems
    Servers

[^1]:    $S=$ START Condition
    $\mathrm{P}=\mathrm{STOP}$ Condition
    $\mathrm{Sr}=$ Repeated START Condition
    D.C. = Don't Care

